

FEUL670100-02

ML670100 User's Manual

32-bit General Purpose ARM-based Microcontroller

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Preface

This Development Specification contains hardware and software specifications of LAPIS Semiconductor's ML670100 32-bit microcontroller. The manuals shown below are also available, and should be consulted a necessary.

ARM Architecture Reference Manual

• Description of ARM instruction set architecture

ARM7TDMI Data Sheet

- Description of ARM7TDMI instruction set
- Description of ARM7TDMI operation

ARM Software Development Toolkit (Ver. 2.50) User's Guide

• Guidance on software development and debug environment using ARM development environment SDT (Software Development Toolkit)

ARM Software Development Toolkit (Ver. 2.50) Reference Guide

• Reference for software development and debug environment using ARM development environment SDT (Software Development Toolkit)

The above documents are published by ARM Corporation. Please ensure that you refer to the latest versions.

Notation

This manual uses the following notational conventions.

Туре	Notation	Meaning
v Numerals	0x <i>nn</i>	Hexadecimal number
v Units	word, WORD	1 word = 32 bits
	byte, BYTE	1 byte = 8 bits
	M (mega-)	10^{6}
	K (Kilo-)	$2^{10} = 1024$
	k (kilo-)	$10^3 = 1000$
	m (milli-)	10 ⁻³
	μ (micro)	10 ⁻⁶
	n (nano-)	10 ⁻⁹
	S	second(s)
v Terms	"H" level	The VIH or VOH voltage level stipulated in the Electrical Characteristics as the voltage high signal level
	"L" level	The VIL or VOL voltage level stipulated in the Electrical Characteristics as the voltage low signal level

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1 Overview

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1.1 Features

ML670100 is a high-performance 32-bit microcontroller combining a RISC-based, 32-bit CPU core - the ARM7TDMI developed by ARM Limited - with memory (ROM and RAM) and such peripheral circuits as timers, serial ports, and an analog-to-digital converter. This combination of 32-bit data processing, built-in memory, and on-chip peripherals make it ideal for controlling equipment requiring both high speed and high functionality. An external memory controller supports direct connection to memory (SRAM, DRAM, etc.) and peripheral devices for adding even more functionality.

The following is a list of features.

- CPU
 - RISC-based, 32-bit CPU core (ARM7TDMI)
 - Two instruction sets
 - The programmer can freely switch between a 32-bit instruction set deriving maximum performance and a 16-bit instruction set providing minimal code size.
 - General-purpose registers: 32 bits x 29
 - Built-in multiplier
- On-chip memory
 - ROM: 128 kilobytes
 - RAM: 4 kilobytes
- Standby function - HALT mode
- Port functions
 - I/O ports: 8 bits x 9
 - I/O directions are specified at the bit level.
 - Analog input port: 8 bits x 1
- Clock generator
 - Built-in crystal oscillator circuit
 - Built-in phase-locked loop for generating operating clock frequencies double or quadruple the crystal oscillator frequency
 - Choice of multipliers (1/1, 1/2, and 1/4) for adjusting operating clock frequency to match load of processing
- Time Base Generator (TBG)
 - Time base clock signals for on-chip peripherals
 - Built-in Watchdog Timer (WDT)
- Flexible Timer (FTM)
 - 16-bit timer with 6 channels
 - Choice of operating modes: auto-reload timer (ART), compare out (CMO), pulse width modulation (PWM), and capture (CAP)

Serial ports

- One asynchronous serial port (UART) with built-in baud rate generator
- Two clock synchronous serial ports
- Analog-to-digital converter
 - 8-bit resolution
 - Analog input port with eight channels
- Interrupt controller
 - Support for 28 sources: 9 external and 19 internal
 - Choice of eight priority levels for each source

• External memory controller

- Direct connection to ROM, SRAM, DRAM, and peripheral devices
- Support for four banks: two for ROM, SRAM, and I/O devices plus two for DRAM
- User-configurable wait control and other parameters for accessing memory and other external devices
- Package
 - 144-pin LQFP (LQFP144-P-2020-0.50-K)

1.2 Block Diagram

Figure 1-1 gives a block diagram for this LSI.



Figure 1-1 : Block Diagram

1.3 Pins

1.3.1 Pin Layout

Figure 1-2 gives the pin layout for this LSI.



- Directly connect all VDD pins to external power supplies and ground all VSS pins.

- AVDD, AGND, and VREF are the power supply, ground, and reference voltage pins for the analog-to-digital converter (ADC).

Connect AVDD and VREF to VDD and AGND to VSS.

Figure 1-2 : Pin Layout

1.3.2 Pin Functions

Table 1.1 lists the functions of each pin.

Гуре	Signal Name	Pin Number	I/O Direction	Description
Address ous	XA23-XA16	66-59	Output	These are bits 23 - 16 of the external address bus. They represent secondary functions for I/O port PIO0[7:0].
	XA15-XA0	56-49 46-39	Output	These are bits 15 - 0 of the external address bus.
Data bus	XD15-XD8	88-81	Bi-directional	These are bits 15 - 8 of the external data bus. They represent secondary functions for I/O port PIO1[7:0].
	XD7-XD0	78-71	Bi-directional	These are bits 7 - 0 of the external data bus.
Bus	nCS0	89	Output	This output is the chip select signal for bank 0.
control signals	nCS1	100	Output	This output is the chip select signal for bank 1. It represents a secondary function for I/O port PIO2[6].
-	nRD	90	Output	This output is the read signal for the SRAM banks (0 and 1).
	nWRL	91	Output	This output is the Write Enable Low signal for the SRAM banks (0 and 1).
1	nWRH	99	Output	This output is the Write Enable High signal for the SRAM banks (0 and 1). It represents a secondary function for I/O port PIO2[5].
	nWRE	91	Output	This output is the Write Enable signal for the SRAM banks (0 and 1).
	nLB	39	Output	This output is the Low Byte Select signal for the SRAM banks (0 and 1).
	nHB	99	Output	This output is the High Byte Select signal for the SRAM banks (0 and 1). It represents a secondary function for I/O port PIO2[5].
	nRAS0	96	Output	This output is the Row Address Strobe signal for bank 2. It represents a secondary function for I/O port PIO2[2].
	nRAS1	98	Output	This output is the Row Address Strobe signal for bank 3. It represents a secondary function for I/O port PIO2[4].
	nCASL	95	Output	This output is the Column Address Strobe Low signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[1].
	nCASH	97	Output	This output is the Column Address Strobe High signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[3].
	nWE	94	Output	This output is the Write Enable signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[0].

Table 1.1 : Pin Functions

Туре	Signal Name	Pin Number	I/O Direction	Description
Bus control signals	nCAS	95	Output	This output is the Column Address Strobe signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[1].
	nWH	97	Output	This output is the Write Enable High signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[3].
	nWL	94	Output	This output is the Write Enable Low signal for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[0].
	nXWAIT	101	Input	This input pin controls insertion of wait cycles. It represents a secondary function for I/O port PIO2[7].
	nBREQ	27	Input	This input is a bus request signal from an external device. It represents a secondary function for I/O port PIO7[6].
	nBACK	28	Output	This output is an acknowledgment signal to a bus request signal from an external device. It represents a secondary function for I/O port PIO7[7].
Interrupts	nEFIQ	67	Input	This input is an external fast interrupt request (FIQ). When accepted, the request is processed as an FIQ exception.
	nEIR[7:0]	111-104	Input	These inputs are external interrupt requests. They represent secondary functions for I/O port PIO3[7:0].
Timers	TMIN[5:0]	118-113	Input	These pins function as capture trigger input pins for Flexible Timer (FTM) channels 5 - 0 in capture (CAP) mode. They represent secondary functions for I/O port PIO4[5:0].
	TMOUT[5:0]	118-113	Output	These pins function as output pins for Flexible Timer(FTM) channels 5 - 0 in compare out (CMO) or pulse width modulation (PWM) mode. They represent secondary functions for I/O port PIO4[5:0].
	TMCLK[1:0]	120,119	Input	These pins function as Flexible Timer (FTM) channel 1 and 0 clock input pins. They represent secondary functions for I/O port PIO4[7:6].
Serial ports	ASI_TXD	130	Output	This output is the transmit data for the Asynchronous Serial Interface (ASI). It represents a secondary function for I/O port PIO5[7].
	ASI_RXD	129	Input	This input is the receive data for the Asynchronous Serial Interface (ASI). It represents a secondary function for I/O port PIO5[6].
	CSI0_TXD	125	Output	This output is the transmit data for the Clock Synchronous Interface 0(CSI0). It represents a secondary function for I/O port PIO5[2].
	CSI0_RXD	124	Input	This input is the receive data for the Clock Synchronous Interface 0 (CSI0). It represents a secondary function for I/O port PIO5[1].

Table 1.1 : Pin Functions

Table 1.1 : Pin Functions						
Туре	Signal Name	Pin Number	I/O Direction	Description		
Serial ports	CSI0_SCLK	123	Bi-directional	This pin accepts/provides the clock signal for the Clock Synchronous Interface 0 (CSI0). It represents a secondary function for I/O port PIO5[0].		
	CSI1_TXD	128	Output	This output is the transmit data for the Clock Synchronous Interface 1 (CSI1). It represents a secondary function for I/O port PIO5[5].		
	CSI1_RXD	127	Input	This input is the receive data for the Clock Synchronous Interface 1 (CSI1). It represents a secondary function for I/O port PIO5[4].		
	CSI1_SCLK	126	Bi-directional	This pin accepts/provides the clock signal for the Clock Synchronous Interface 1 (CSII). It represents a secondary function for I/O port PIO5[3].		
Analog-to- digital	VREF	6	Input	This input is the reference voltage for the analog-to-digital converter. Connect it to V DD.		
converter	AI[7:0]	142-144 1-5	Input	These are analog signal input pins for analog-to-digital converter channels 7 - 0.		
Debugging interface	TDI	36	Input	This input is the serial data input for the debugging scan circuit. It represents the secondary function for I/Oport PIO8[7].		
	TDO	35	Output	This output is the serial data output for the debugging scan circuit. It represents the secondary function for I/O port PIO8[6].		
	nTRST	34	Input	"L" level input to this pin resets the debugging scan circuit. It represents the secondary function for I/O port PIO8[5].		
	TMS	33	Input	This input selects the mode for the debugging scan circuit. It represents the secondary function for I/O port PIO8[4].		
	ТСК	32	Input	This input is the serial clock input for the debugging scan circuit. It represents the secondary function for I/O port PIO8[3].		
	DBGEN	31	Input	"High" level input to this pin enables the CPU's debugging function. It represents the secondary function for I/O port PIO8[2].		
	DBGRQ	30	Input	This input is a debugging request signal from an external device. It represents the secondary function for I/O port PIO8[1].		
	DBGACK	29	Output	This output is an acknowledgment signal to a debugging request signal from an external device. It represents the secondary function for I/O port PIO8[0].		

Table 1.1	1: Pin Function	IS	-	
Туре	Signal Name	Pin Number	I/O Direction	Description
I/O ports	PIO8[7:0]	36-29	Bi-directional	These form an 8-bit I/O port. I/O directions are specified
				at the bit level.
	PIO7[7:0]	28-24	Bi-directional	These form an 8-bit I/O port. I/O directions are specified
		21-19		at the bit level.
	PIO6[7:0]	18-11	Bi-directional	These form an 8-bit I/O port. I/O directions are specified
				at the bit level.
	PIO5[7:0]	130-123	Bi-directional	These form an 8-bit I/O port. I/O directions are specified at the bit level.
	PIO4[7:0]	120-113	Bi-directional	These form an 8-bit I/O port. I/O directions are specified at the bit level.
	PIO3[7:0]	111-104	Bi-directional	These form an 8-bit I/O port. I/O directions are specified at the bit level.
	PIO2[7·0]	101-94	Ri-directional	These form an 8-bit I/O port I/O directions are specified
	1102[7.0]	101 21	Di unecciona.	at the bit level.
	PIO1[7:0]	88-81	Bi-directional	These form an 8-bit I/O port. I/O directions are specified
	1.0.1[,]	00 01	Di unocencia	at the bit level.
	PIO0[7:0]	66-59	Bi-directional	These form an 8-bit I/O port. I/O directions are specified
	* · [,]			at the bit level.
Clock	OSC0	133	Input	This pin is for connecting a crystal oscillator. If an
control			±	external clock is used, supply it to this pin.
	OSC1	134	Output	This pin is for connecting a crystal oscillator. If an
			-	external clock is used, leave this pin open.
	CLKOUT	131	Output	This output is the internal system clock (SYSCLK) signal.
	FSEL	137	Input	Connect this pin to VDD or ground to indicate the
			<u> </u>	frequency range for the basic clock.
	PLLEN	138	Input	Connecting this pin to VDD enables the built-in
			*	phase-locked loop. If the PLL is not used because an
				external clock with a guaranteed duty is available, connect
				this pin to ground.
	VCOM	136	Input	This input controls the oscillation frequency of the PLL's
				voltage-controlled oscillator. Connect it to ground.
System	nRST	139	Input	"L" level input to this pin produces an external system
control			-	reset for this LSI. "H" level input then causes execution to
				resume from address 0x000000.
	DBSEL	10	Input	During a system reset of this LSI, this input specifies the
			-	width of the external data bus for bank 0. Connect this pin
				to VDD for a data bus width of 16 bits and to ground for 8
				bits.
	nEA	68	Input	During a system reset of this LSI, this input controls the
				use of the internal ROM. Connect this pin to VDD to
				enable the ROM and to ground to disable it

Table 1.7	1: Pin Function	IS		
Туре	Signal Name	Pin	I/O Direction	Description
		Number		
System	TEST	9	Input	During a system reset of this LSI, this input controls the
control				initial pin functions for the I/O port 8 pins (PIO8[7:0]).
				Connect this pin to VDD to initialize the port for its
				secondary function, the debugging interface, and to
				ground for I/O.
Power	VDD	8,23,38,	Input	These pins are this LSI's power supply pins. Connect
supply		48,58,70,		them all to VDD.
		80,93,		
		103,122,		
		135		
	GND	22,37,47,	Input	These pins are this LSI's ground pins. Connect them all
		57,69,79,		to ground.
		92,102,		
		112,121,		
		132,140		
	AVDD	7	Input	This pin is the analog-to-digital converter's power
				supply. Connect it to VDD.
	AGND	141	Input	This pin is the analog-to-digital converter's ground pin.
				Connect it to ground.

1.3.3 Treatment of Unused Pins

Table 1.2 lists the connections for unused pins.

Pin Name(s)	Treatment
PIO8-PIO0	Input configuration: Connect to VDD or ground through resistors.
	Output configuration: Leave open.
nEFIQ	Connect to VDD.
VREF	Connect to VDD.
AI [7:0]	Connect to VDD or ground.
TEST	Connect to VDD or ground.
nTRST	Connect to ground through resistors
TDI,TMS,TCK	Connect to VDD through resistors
TDO	Leave open







(5) I/O port A (I/O ports without secondary functions) PIO6[7:0], PIO7[5:0]

(6) I/O port B (I/O ports with secondary functions of input)

PIO2[7], PIO3[7:0], PIO4[7:6], PIO5[6], PIO5[4], PIO5[1], PIO7[6], PIO8[7], PIO8[5:1]



(7) I/O port C (I/O ports with secondary functions of output)

PIO5[7], PIO5[5], PIO5[2], PIO7[7], PIO8[6], PIO8[0]











2 CPU

This LSI uses as its CPU the ARM7TDMI core developed by ARM Limited. This CPU offers the programmer a choice of two states: ARM state, executing 32-bit ARM instructions, and THUMB state, executing 16-bit THUMB instructions, a subset of ARM instructions.

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2.1 CPU Operating States

From the programmer's point of view, the CPU can be in one of two states:

ARM state which executes 32-bit, word-aligned ARM instructions.

THUMB state which operates with 16-bit, halfword-aligned THUMB instructions. In this state, the PC uses bit 1 to select between alternate halfwords.

Note : Transition between these two states does not affect the CPU mode or the contents of the registers.

2.2 Switching State

Entering THUMB state

Entry into THUMB state can be achieved by executing a BX instruction with the state bit (bit 0) set in the operand register.

Transition to THUMB state will also occur automatically on return from an exception(IRQ, FIQ, UNDEF, SWI etc.), if the exception was entered with the processor in THUMB state.

Entering ARM state

Entry into ARM state happens:

- 1 On execution of the BX instruction with the state bit clear in the operand register.
- 2 On the processor taking an exception (IRQ, FIQ, RESET, UNDEF, SWI etc.). In this case, the PC is placed in the exception mode's link register, and execution commences at the exception's vector address.

2.3 Memory Formats

The CPU views memory as a linear collection of bytes numbered upwards from zero. Bytes 0 to 3 hold the first stored word, bytes 4 to 7 the second and so on. The CPU can treat words in memory as being stored in Little Endian format.

Note : The core architecture supports both big- and little- endian formats, but this LSI uses only the latter.

Higher Address	31	24 23	16 15	87	0	Word Address
	11	10	9	8		8
	7	6	5	4		4
	3	2	1	0		0
Lower Address						
	-Le	east significa	int byte is at	lowest add	lress	

-Word is addressed by byte address of least significant byte

Figure 2.1 : Little endian addresses of bytes within words

2.4 Instruction Length

Instructions are either 32 bits long (in ARM state) or 16 bit long (in THUMB state).

2.5 Data Types

The CPU supports byte (8-bit), halfword (16-bit) and word (32-bit) data types. Words must be aligned to four-byte boundaries and half words to two-byte boundaries.

2.6 Operating Modes

The CPU supports six modes of operation:

use it.

User (usr):		The normal ARM program execution state
FIQ(fiq):		Designed to support a data transfer or channel process
IRQ(irq):		Used for general-purpose interrupt handling
Supervisor (sys):	Protected mode for the operating system.
System (sys)	:	A privileged user mode for the operating system
Undefined(u	nd):	Entered when an undefined instruction is executed
Note :	The core archite	ecture offers an additional mode, Abort mode, but this LSI does not

Mode changes may be made under software control, or may be brought about by interrupts or exception processing. Most application programs will execute in User mode. The non-user modes -known as privileged modes- are entered in order to service interrupts or exceptions, or to access protected resources.

2.7 Registers

The CPU has a total of 34 registers -29 general-purpose 32-bit registers and five status registers- but these cannot all be seen at once. The CPU state and operating mode dictate which registers are available to the programmer.

Note : The core architecture offers an additional two general-purpose registers and one status register for use with the Abort mode, which this LSI does not support.

2.7.1 The ARM state register set

In ARM state, 16 general registers and one or two status registers are visible at any one time. In privileged (non-User) modes, mode-specific banked registers are switched in. Figure 2.2 : Register organization in ARM state shows which registers are available in each mode: the banked registers are marked with a shaded triangle. The ARM state register set contains 16 directly accessible registers: R0 to R15. All of these except R15 are general-purpose, and may be used to hold either data or address values. In addition to these, there is a seventeenth register used to store status information.

- Register 14 is used as the subroutine link register. This receives a copy of R15 when a Branch and Link (BL) instruction is executed. At all other times it may be treated as a general-purpose register. The corresponding banked registers R14_svc, R14_irg, R14_fiq, and R14_und are similarly used to hold the return values of R15 when interrupts and exceptions arise, or when Branch and Link instructions are executed within interrupt or exception routines.
- Register 15 holds the Program Counter (PC). In ARM state, bits [1:0] of R15 are zero and bits [31:2] contain the PC. In THUMB state, bit [0] is zero and bits [31:1] contain the PC.
- Register 16 is the CPSR (Current Program Status Register). This contains condition code flags and the current mode bits.

FIQ mode has seven banked registers mapped to R8-14 (R8_fiq-R14_fiq). In ARM state, many FIQ handlers do not need to save any registers. User, IRQ, Supervisor and Undefined each have two banked registers mapped to R13 and R14, allowing each of these modes to have a private stack pointer and link registers.

System & User	FIQ	Supervisor	IRQ	Undefined
R0	R0	R0	R0	R0
R1	R1	R1	R1	R1
R2	R2	R2	R2	R2
R3	R3	R3	R3	R3
R4	R4	R4	R4	R4
R5	R5	R5	R5	R5
R6	R6	R6	R6	R6
R7	R7	R7	R7	R7
R8	R8_fiq	R8	R8	R8
R9	R9_fiq	R9	R9	R9
R10	R10_fiq	R10	R10	R10
R11	R11_fiq	R11	R11	R11
R12	R12_fiq	R12	R12	R12
R13	R13_fiq	R13_svc	R13_irq	R13_und
R14	R14_fiq	R14_svc	R14_irq	R14_und
R15(PC)	R15(PC)	R15(PC)	R15(PC)	R15(PC)

ARM State General Registers and Program Counter

ARM State Program Status Registers



=banked register

Figure 2.2 : Register organization in ARM state

2.7.2 The THUMB state register set

The THUMB state register set is a subset of the ARM state set. The programmer has direct access to eight general registers, R0-R7, as well as the Program Counter (PC), a stack pointer register (SP), a link register (LR), and the CPSR. There are banked Stack Pointers, Link Registers and Saved Program Status Registers (SPSRs) for each privileged mode. This is shown in Figure 2.3: Register organization in THUMB state.

System & User	FIQ	Supervisor	IRQ	Undefined
R0	R0	R0	R0	R0
R1	R1	R1	R1	R1
R2	R2	R2	R2	R2
R3	R3	R3	R3	R3
R4	R4	R4	R4	R4
R5	R5	R5	R5	R5
R6	R6	R6	R6	R6
R7	R7	R7	R7	R7
SP	SP _fiq	SP_svc	SP_irq	SP_und
LR	LR_fiq	LR_svc	LR_irq	LR_und
PC	PC	PC	PC	PC

THUMB State General Registers and Program Counter

THUMB State Program Status Registers



=banked register

Figure 2.3 : Register organization in THUMB state

2.7.3 The relationship between ARM and THUMB state registers

The THUMB state registers relate to the ARM state registers in the following way:

- THUMB state R0-R7 and ARM state R0-R7 are identical
- THUMB state CPSR and SPSRs and ARM state CPSR and SPSRs are identical
- THUMB state SP maps onto ARM state R13
- THUMB state LR maps onto ARM state R14
- The THUMB state Program Counter maps onto the ARM state Program Counter (R15)

This relationship is shown in Figure 2.4: Mapping of THUMB state registers onto ARM state registers.

THUMB State	_	ARM State	_	
R0	│	R0		
R1		R1		
R2		R2		S
R3		R3		ste
R4		R4		egi
R5		R5		20
R6		R6		Ē
R7		R7		
		R8		
		R9		
		R10		ຽ
		R11		ste
		R12		fegi
Stack Pointer (SP)		Stack Pointer (R13)		r
Link Register (LR)		Link Register (R14)		
Program Counter (PC)	├	Program Counter (R15)		
CPSR	───→	CPSR		
SPSR		SPSR		

Figure 2.4 : Mapping of THUMB state registers onto ARM state registers

2.7.4 Accessing Hi registers in THUMB state

In THUMB state, registers R8-R15 (the Hi registers) are not part of the standard register set. However, the assembly language programmer has limited access to them, and can use them for fast temporary storage.

A value may be transferred from a register in the range R0-R7 (a Lo register) to a Hi register, and from a Hi register to a Lo register, using special variants of the MOV instruction. Hi register values can also be compared against or added to Lo register values with the CMP and ADD instructions.

2.8 The Program Status Registers

The CPU contains a Current Program Status Register (CPSR), plus four Saved Program Status Registers (SPSRs) for use by exception handlers. These registers

- hold information about the most recently performed ALU operation
- control the enabling and disabling of interrupts
- set the processor operating mode

The arrangement of bits is shown in Figure 2.5: Program status register format.



Figure 2.5 : Program status register format

2.8.1 The condition code flags

The N, Z, C and V bits are the condition code flags. These may be changed as a result of arithmetic and logical operations, and may be tested to determine whether an instruction should be executed.

In ARM state, all instructions may be executed conditionally. In THUMB state, only the Branch instruction is capable of conditional execution.

2.8.2 The control bits

The bottom 8 bits of a PSR (incorporating I, F, T and M [4:0]) are known collectively as the control bits. These will change when an exception arises. If the CPU is executing in a privileged mode, they can also be manipulated by software.

The T bit	This reflects the operating state. When this bit is set, the CPU is executing in THUMB state, otherwise it is executing in ARM state.
	Note that the software must never change the state of the TBIT in the CPSR. If this happens, the CPU will enter an unpredictable state.
Interrupt disable bits	The I and F bits are interrupt disable bits. When set, these disable the IRQ and FIQ interrupts respectively.

The mode bits	The M4, M3, M2, M1 and M0 bits (M[4:0]) are the mode bits. These determine the CPU's operating mode, as shown in Table 2.1 PSR mode bit values. Not all combinations of the mode bits define a valid CPU mode. Only those explicitly described shall be used. The user should be aware that if any illegal value is programmed into the mode bits, M [4:0], then the CPU will enter an unrecoverable state. If this occurs, reset should be applied.
Reserved bits	The remaining bits in the PSRs are reserved. When changing a PSR's flag or control bits, you must ensure that these unused bits are not altered. Also, your program should not rely on them containing specific values, since in future CPUs they may read as one or zero.

M[4:0]	Mode	Visible THUMB state registers	Visible ARM state registers
10000	User	R7R0, LR, SP PC, CPSR	R14R0, PC, CPSR
10001	FIQ	R7R0, LR_fiq, SP_fiq PC, CPSR, SPSR_fiq	R7R0, R14_fiqR8_fiq, PC, CPSR, SPSR_fiq
10010	IRQ	R7R0, LR_irq, SP_irq PC, CPSR, SPSR_irq	R12R0, R14_irqR13_irq, PC, CPSR, SPSR_irq
10011	Supervisor	R7R0, LR_svc, SP_svc, PC, CPSR, SPSR_svc	R12R0, R14_svcR13_svc, PC, CPSR, SPSR_svc
11011	Undefined	R7R0 LR_und, SP_und, PC, CPSR, SPSR_und	R12R0, R14_undR13_und, PC, CPSR
11111	System	R7R0, LR, SP PC, CPSR	R14R0, PC, CPSR

2.9 Exceptions

Exceptions arise whenever the normal flow of a program has to be halted temporarily, for example to service an interrupt from a peripheral. Before an exception can be handled, the current CPU state must be preserved so that the original program can resume when the handler routine has finished.

It is possible for several exceptions to arise at the same time. If this happens, they are dealt with in a fixed order -see 2.9.9 Exception priorities.
2.9.1 Action on entering an exception

When handling an exception, the CPU:

- Preserves the address of the next instruction in the appropriate Link Register. If the exception has been entered from ARM state, then the address of the next instruction is copied into the Link Register (that is, current PC + 4 or PC + 8 depending on the exception. See Table 2.2 Exception entry/exit for details). If the exception has been entered from THUMB state, then the value written into the exception has been entered from THUMB state, then the value written into the exception has been entered from THUMB state, then the value written into the Link Register is the current PC offset by a value such that the program resumes from the correct place on return from the exception. This means that the exception handler need not determine which state the exception was entered from. For example, in the case of SWI, MOVS PC, R14_svc will always return to the next instruction regardless of whether the SWI was executed in ARM or THUMB state.
- 2 Copies the CPSR into the appropriate SPSR
- 3 Forces the CPSR mode bits to a value which depends on the exception
- 4 Forces the PC to fetch the next instruction from the relevant exception vector

It may also set the interrupt disable flags to prevent otherwise unmanageable nestings of exceptions.

If the CPU is in THUMB state when an exception occurs, it will automatically switch into ARM state when the PC is loaded with the exception vector address.

2.9.2 Action on leaving an exception

On completion, the exception handler:

- 1 Moves the Link Resister, minus an offset where appropriate, to the PC.(The offset will vary depending on the type of exception.)
- 2 Copies the SPSR back to the CPSR
- 3 Clears the interrupt disable flags, if they were set on entry
- **Note :** An explicit switch back to THUMB state is never needed, since restoring the CPSR from the SPSR automatically sets the T bit to the value it held immediately prior to the exception.

2.9.3 Exception entry/exit summary

Table 2.2 : Exception entry/exit summarizes the PC value preserved in the relevant R14 on exception entry, and the recommended instruction for exiting the exception handler.

Table 2.2 : Exception entry/exit					
	Return Instruction	Previous ARM R14_x	State THUMB R14_x	Notes	
BL	MOV PC, R14	PC + 4	PC + 2	1	
SWI	MOVS PC, R14_svc	PC + 4	PC + 2	1	
UDEF	MOVS PC, R14_und	PC + 4	PC + 2	1	
FIQ	SUBS PC, R14_fiq, #4	PC + 4	PC + 4	2	
IRQ	SUBS PC, R14_irq, #4	PC + 4	PC + 4	2	
RESET	NA	-	-	3	

Note :

- 1 Where PC is the address of the BL/SWI/Undefined Instruction.
- 2 Where PC is the address of the instruction which did not get executed since the FIQ or IRQ took priority.
- 3 The value saved in R14_svc upon reset is unpredictable.

2.9.4 FIQ

The FIQ (Fast Interrupt Request) exception is designed to support a data transfer or channel process, and in ARM state has sufficient private registers to remove the need for register saving (thus minimizing the overhead of context switching).

Irrespective of whether the exception was entered from ARM or Thumb state, a FIQ handler should leave the interrupt by executing

SUBS PC, R14_fig, #4

FIQ may be disabled by setting the CPSR's F flag (but note that this is not possible from User mode).

2.9.5 IRQ

The IRQ (Interrupt Request) exception is a normal interrupt. IRQ has a lower priority than FIQ and is masked out when a FIQ sequence is entered. It may be disabled at any time by setting the I bit in the CPSR, though this can only be done from a privileged (non-User) mode.

Irrespective of whether the exception was entered from ARM or Thumb state, an IRQ handler should return from the interrupt by executing.

SUBS PC, R14_irq, #4

2.9.6 Software interrupt

The software interrupt instruction (SWI) is used for entering Supervisor mode, usually to request a particular supervisor function. A SWI handler should return by executing the following irrespective of the state (ARM or Thumb):

MOV PC, R14_svc

This restores the PC and CPSR, and returns to the instruction following the SWI.

2.9.7 Undefined instruction

When the CPU comes across an instruction which it cannot handle, it takes the undefined instruction trap. This mechanism may be used to extend either the THUMB or ARM instruction set by software emulation.

After emulating the failed instruction, the trap handler should execute the following irrespective of the state (ARM or Thumb):

MOVS PC, R14_und

This restores the CPSR and returns to the instruction following the undefined instruction.

2.9.8 Exception vectors

The following table shows the exception vector addresses.

Table 2.3 : Exception vectors

Address	Exception	Mode on entry
0x00000000	Reset	Supervisor
0x00000004	Undefined instruction	Undefined
0x0000008	Software interrupt	Supervisor
0x0000000C	Reserved	Reserved
0x00000010	Reserved	Reserved
0x00000014	Reserved	Reserved
0x00000018	IRQ	IRQ
0x0000001C	FIQ	FIQ

2.9.9 Exception priorities

When multiple exceptions arise at the same time, a fixed priority system determines the order in which they are handled:

Highest priority:

1	Reset
2	FIQ
3	IRQ

Lowest priority:

4 Undefined Instruction, software interrupt.

Not all exceptions can occur at once:

Undefined Instruction and Software Interrupt are mutually exclusive, since they each correspond to particular (non-overlapping) decodings of the current instruction.

2.10 Reset

After a system reset, the CPU:

- 1 Overwrites R14_svc and SPSR_svc by copying the current values of the PC and CPSR into them. The value of the saved PC and SPSR is not defined.
- 2 Forces M [4:0] to 10011(Supervisor mode), sets the I and F bits in the CPSR.
- 3 Forces the PC to fetch the next instruction from address 0x00.
- 4 Execution resumes in ARM state.

3 CPU Control Functions

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3.1 Overview

CPU control functions for this LSI include the following.

Reset control

This function controls the system reset function for initializing the CPU and on-chip peripherals.

- Clock control This function controls the oscillator circuit based on a crystal oscillator and a built-in phase-locked loop which together generate and control the system clock (SYSCLK) signal. It offers a choice of divider ratio (1/1, 1/2, and 1/4) for adjusting operating clock frequency to match the load of processing.
- Standby mode control This function controls the transitions to and from HALT mode.

3.1.1 Pins

Table 3.1 lists the pins connected to the CPU control unit.

Pin Name	Symbol	Direction	Description
Reset input	nRST	input	"L" level input to this pin produces an external system reset for this LSI. "H" level input then causes execution to resume from address 0x000000.
Crystal oscillator input pin	OSC0	input	This pin is for connecting a crystal oscillator. If an external clock is used, supply it to this pin.
Crystal oscillator output pin	OSC1	output	This pin is for connecting a crystal oscillator. If an external clock is used, leave this pin open
System clock (SYSCLK) output	CLKOUT	output	This output is the internal system clock (SYSCLK) signal.
PLL enable input	PLLEN	input	Connecting this pin to V DD enables the built-in phase-locked loop. If the PLL is not used because an external clock with a guaranteed duty is available, connect this pin to ground.
PLL frequency divider selection input	FSEL	input	Connect this pin to V DD or ground to indicate the frequency range for the basic clock.
VCO frequency selection input	VCOM	input	This input controls the oscillation frequency of the PLL's voltage-controlled oscillator. Connect it to ground.

Table 3.1 : CPU Control Unit Pins

3.1.2 Control Registers

Table 3.2 lists the control registers for the CPU control unit.

Reads from these control registers takes exactly one clock cycle; writes, at least two. Modifying the standby control (SBYCON) or clock control (CKCON) register requires two operations: writing 0x0000003C and then writing the new value. Without the first, the second is ignored.

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x040_0000	Standby Control Register	SBYCON	W	32	0x00000000
0x040_0004	Clock Control Register	CKCON	R/W	32	0x00000000
0x040_000C	Reset Status Register	RSTST	R	32	0x00000000

Table 3.2 : CPU Control Unit Control Registers

3.2 Control Registers

3.2.1 Standby Control Register (SBYCON)

The Standby Control Register (SBYCON) is a 32-bit write-only register containing a control bit for switching to HALT mode. After a system reset, it contains 0x00000000.

31	30	 3	2	1	0
0	0	0	0	0	HLT

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 3.1 : Standby Control Register (SBYCON)

Bit Descriptions

HLT

This is HALT mode control bit. Writing "1" to this bit switches this LSI to HALT mode, suspending operation of the CPU, but leaving the peripheral circuits operational. The LSI automatically resets this bit to "0" when it wakes from HALT mode.

The LSI ignores the above transition requests when

- a preceding interrupt request has set a bit in the Interrupt Request Registers 0 to 3 (IRRn, n=0 3) to "1" and the corresponding interrupt level for the interrupt in the Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 15) is nonzero that is, 1 to 7.
- (2) a preceding external fast interrupt request (FIQ) has set the EFIQR bit in the External FIQ Control Register (EFIQCON) to "1" and the EFIQM bit in the same register does not mask such requests that is, is "0".
- (3) I/O port 8 is configured for its secondary function, and DBGRQ (PIO8[1]) is asserted.

In the first case, either clear the bit in the Interrupt Request Register (IRRn) or set the interrupt level to zero and then write to SBYCON.

In the second case, either clear the EFIQR bit to "0" or mask external fast interrupt requests by setting the EFIQM bit to "1" and then write to SBYCON.

In the third case, wait for the external device to negate DBGRQ, terminating debugging, and then write to SBYCON.

3.2.2 Clock Control Register (CKCON)

The Clock Control Register (CKCON) is a 32-bit read/write register controlling the frequency divider ratio for the system clock (SYSCLK) signal for the CPU and on-chip peripherals. After a system reset, it contains 0x00000000.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 3.2 : Clock Control Register (CKCON)

Bit Descriptions

CKM

This field specifies a frequency divider ratio. The choices are 1, 1/2, and 1/4. The LSI applies this ratio to the PLL output to derive the system clock (SYSCLK) signal for the CPU and on-chip peripherals.

3.2.3 Reset Status Register (RSTST)

The Reset Status Register (RSTST) is a 32-bit read-only register indicating the trigger for the most recent system reset. The external reset signal (nRST) sets this register to 0x00000000; the Watchdog Timer (WDT) counter overflow signal (WDTOV), to 0x00000001.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 3.4 : Reset Status Register (RSTST)

Bit Descriptions

WDTRST

This flag indicates the trigger for the most recent system reset. A "0" indicates the external reset signal (nRST); a "1," the Watchdog Timer (WDT) counter overflow signal(WDTOV).

3.3 System Resets

This LSI has two sources for system resets:

- External reset signal (nRST)
- Watchdog Timer (WDT) counter overflow signal (WDTOV)

3.3.1 External Reset Signal (nRST)

Asserting the external reset signal (nRST) asserts the LSI's internal reset signal for the assert time plus nine clock cycles, resetting the CPU and on-chip peripherals and initializing the following registers.

- The LSI initializes the Standby Control Register (SBYCON) to 0x00000000 and wakes from HALT mode.
- The LSI initializes the Reset Status Register (RSTST) to 0x00000000.

It is up to the signal source to assert the signal long enough to cover both the crystal oscillator circuit stabilization period and the PLL lock time.

3.3.2 Watchdog Timer (WDT) Counter Overflow

Watchdog Timer (WDT) counter overflow signal (WDTOV) asserts the internal reset signal for nine clock cycles, resetting the CPU and all on-chip peripherals except the I/O ports, and the Clock Control Register (CKCON) in the CPU control unit. By not initializing the I/O ports and CKCON, the LSI maintains the I/O port direction settings (input/output), I/O port pin function settings (primary/secondary), I/O port output levels and CKCON setting (clock frequency divider ratio) in effect before the reset.

- The LSI resets the HLT bit in the Standby Control Register (SBYCON) to "0" to wake from HALT mode.
- The LSI initializes the Reset Status Register (RSTST) to 0x00000001.

3.4 Clock Signals

The basic clock signal is either the oscillation clock from the oscillator circuit or an external clock signal.

Clock source	OSC0	OSC1
External source	Clock input	Open
Crystal oscillator	Connect crystal oscillator	

If the PLLEN input enables PLL operation, specify the frequency multiplier from Table 3.4 matching the frequency range for the basic clock signal from the oscillator circuit or an external clock signal.

Table 3.4 : FSEL Pin Settings

Basic clock frequency from the oscillator circuit or an external clock signal	FSEL Input	Multiplier	PLL Output Clock Frequency
4-6.25MHz	"H" level	x 4	16-25MHz
	(Connect to V DD .)		
8-12.5MHz	"L" level	x 2	
	(Connect to ground.)		

The frequency for the system clock (SYSCLK) signal, the clock for CPU and on-chip peripherals, is determined by the CKM field in the Clock Control Register (CKCON). The frequency of SYSCLK is limited to the range of 4 to 25MHz.

The LSI permits adjusting this setting - and thus the operating clock frequency - to match the processing load.

Table 3.5 : System Clock (SYSCLK) Frequence

СКМ	System clock (SYSCLK) frequency
00	Frequency 1/4 that of PLL output
01	Frequency 1/2 that of PLL output
1X	Frequency 1/1 that of PLL output

 $X: don't \ care$

3.5 Standby Mode

Writing "1" to the HLT bit in the Standby Control Register (SBYCON) switches this LSI to HALT mode. This mode suspends operation of the CPU but the peripheral circuits remain operational.

The LSI remains in HALT mode until one of the following conditions is met:

- There is an external fast interrupt request (FIQ) and such requests are not masked.
- There is an external interrupt request and such requests are not masked.
- There is an internal interrupt request and such requests are not masked.
- An external reset signal (nRST) or Watchdog Timer (WDT) counter overflow signal (WDTOV) produces a system reset.
- I/O port 8 is configured for its secondary function, and DBGRQ (PIO8[1]) is asserted.

Masking an interrupt request, whether external or internal, by setting its interrupt level to 0 prevents it from terminating HALT mode. If the level is 1 or higher, however, the interrupt request always terminates HALT mode even if that level is lower than the current interrupt level, preventing the interrupt request from reaching the CPU itself.

An external fast interrupt request (FIQ) does not terminate HALT mode if such interrupt requests are masked by the EFIQM bit in the External FIQ Control Register (EFIQCON). If masking is off, the interrupt request terminates HALT mode.

4 Interrupt Controller

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4.1 Overview

The interrupt controller manages interrupt requests from 9 external sources and 19 internal ones and passes them on to the CPU as interrupt request (IRQ) or fast interrupt request (FIQ) exception requests. It supports eight interrupt levels for each source for use in priority control.

- The interrupt controller supports 9 external interrupt sources connected to nEFIQ and nEIR[7:0] pins and 19 internal interrupt sources, including the serial ports and the Flexible Timer (FTM) channels.
- The interrupt controller simplifies interrupt priority control with a choice of eight interrupt levels for each source.
- The interrupt controller assigns a unique interrupt number to each source to permit rapid branching to the appropriate routine.

4.1.1 Block Diagram

Figure 4.1 gives a block diagram for the interrupt controller, which includes the following components:

- Interrupt Number Register (INR), which holds the interrupt number for the interrupt request with the highest priority
- Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed
- Interrupt Request Level Register (IRLR), which holds the interrupt level for the interrupt request with the highest priority
- External FIQ Control Register (EFIQCON), which controls processing of external fast interrupt requests
- External IRQ Control Register (EIRCON), which specifies the detection methods for external interrupt requests
- Interrupt Request Registers 0 to 3 (IRRn, n=0 3), which contain flags tracking pending interrupt requests
- Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 15), which specify the interrupt levels for individual interrupt sources
- Interrupt request detection circuitry
- Interrupt priority judgment circuitry



Figure 4.1 : Block Diagram for Interrupt Controller (INT)

4.1.2 Pins

Table 4.1 lists the pins connected to the interrupt controller.

Pin Name	Symbol	Direction	Description				
External fast interrupt	nEFIQ	Input	This pin is exclusively for external fast interrupt requests.				
request							
External interrupt request	nEIR[7:0]	Input	These pins are for external interrupt requests.				
			They represent secondary functions for I/O port				
			PIO3[7:0].				

Table 4.1 : Interrupt Controller (INT) Pins

4.1.3 Control Registers

Table 4.2 lists the control registers for the interrupt controller.

Address Name		Symbol	R/W	Size (bits)	Initial value
0x060_0000	Interrupt Number Register	INR	R	8	Indeterminate
0x060_0002	Current Interrupt Level Register	CILR	R/W	8	0x00
0x060_0003	Interrupt Request Level Register	IRLR	R	8	0x00
0x060_0004	External FIQ Control Register	EFIQCON	R/W	8	0x04/06
0x060_0005	External IRQ Control Register	EIRCON	R/W	8	0x00
0x060_0008	Interrupt Request Register 0	IRR0	R/W	8	0x00
0x060_0009	Interrupt Request Register 1	IRR1	R/W	8	0x00
0x060_000A	Interrupt Request Register 2	IRR2	R/W	8	0x00
0x060_000B	Interrupt Request Register 3	IRR3	R/W	8	0x00
0x060_0010	Interrupt Level Control Register 0	ILCON0	R/W	8	0x00
0x060_0011	Interrupt Level Control Register 1	ILCON1	R/W	8	0x00
0x060_0012	Interrupt Level Control Register 2	ILCON2	R/W	8	0x00
0x060_0013	Interrupt Level Control Register 3	ILCON3	R/W	8	0x00
0x060_0014	Interrupt Level Control Register 4	ILCON4	R/W	8	0x00
0x060_0015	Interrupt Level Control Register 5	ILCON5	R/W	8	0x00
0x060_0016	Interrupt Level Control Register 6	ILCON6	R/W	8	0x00
0x060_0017	Interrupt Level Control Register 7	ILCON7	R/W	8	0x00
0x060_0018	Interrupt Level Control Register 8	ILCON8	R/W	8	0x00
0x060_0019	Interrupt Level Control Register 9	ILCON9	R/W	8	0x00
0x060_001A	Interrupt Level Control Register 10	ILCON10	R/W	8	0x00
0x060_001B	Interrupt Level Control Register 11	ILCON11	R/W	8	0x00
0x060_001C	Interrupt Level Control Register 12	ILCON12	R/W	8	0x00
0x060_001D	Interrupt Level Control Register 13	ILCON13	R/W	8	0x00
0x060_001E	Interrupt Level Control Register 14	ILCON14	R/W	8	0x00
0x060 001F	Interrupt Level Control Register 15	ILCON15	R/W	8	0x00

Table 4.2 : Interrupt Controller (INT) Control Registers

4.2 Interrupt Sources

There are three types of interrupt requests: external fast interrupt requests producing FIQ exception requests, external interrupt requests producing IRQ exception requests, and internal interrupt requests producing IRQ exception requests.

An external fast interrupt request sends the CPU an FIQ exception request unless blocked with the external FIQ mask (EFIQM) flag.

The other two types only send the CPU an IRQ exception request if the interrupt level specified for the corresponding source is higher than the highest level flagged in the Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed. If the source's interrupt level is the same or lower than the highest level flagged in CILR, however, the interrupt request is held pending and only sends the CPU an IRQ exception request when the latter drops below the former.

4.2.1 External Fast Interrupt Requests

If the interrupt controller detects a falling edge in the input signal from the external fast interrupt request (nEFIQ) pin and the external FIQ mask (EFIQM) flag in the External FIQ Control Register (EFIQCON) is "0" - that is, masking is off - it sends the CPU an FIQ exception request. The CPU only accepts this exception request if the F bit in its Current Program Status Register (CPSR) is "0."

4.2.2 External Interrupt Requests

If the interrupt controller detects the input (a falling edge or "L" level) specified with the EIRn (n=0 - 7) bit in the External IRQ Control Register (EIRCON) from External Interrupt Request n pin (nEIR[n], n=0 - 7) and the interrupt level specified for the corresponding source is higher than the highest level flagged in the Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed, it sends the CPU an IRQ exception request. The CPU only accepts this exception request if the I bit in its Current Program Status Register (CPSR) is "0."

4.2.3 Internal Interrupt Requests

Internal interrupt requests come from the following on-chip peripherals:

- Analog-to-Digital Converter (ADC)
- Clock Synchronous Serial Interfaces (CSI0 and CSI1)
- Asynchronous Serial Interface (ASI)
- Time Base Generator (TBG)
- Flexible Timer (FTM)

If the interrupt level specified for the corresponding source is higher than the highest level flagged in the Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed, the interrupt controller sends the CPU an IRQ exception request. The CPU only accepts this exception request if the I bit in its Current Program Status Register (CPSR) is "0."

4.2.4 Interrupt Source Mappings

Table 4.3 lists the interrupt number, request pending flag location in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3), and interrupt level field (ILRn, n=0 - 31) in the Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15) for each source. The final column gives a fixed priority for use in selecting from among interrupt requests with the same interrupt level.

The first column uses the following symbols:

nEFIQ: Interrupt request from external fast interrupt request pin

nEIR[n] (n=0 - 7): Interrupt request from nEIR[n] pin

EVENTn (n=0 - 5): Capture event or compare match interrupt request from Flexible Timer (FTM) channel n

FTMOVn (n=0 - 5): Timer overflow interrupt request from Flexible Timer (FTM) channel n

WDINT: Watchdog Timer (WDT) interrupt request signal from Time Base Generator (TBG)

RVINT: Receive ready interrupt request from Asynchronous Serial Interface (ASI)

TRINT: Transmit ready interrupt request from Asynchronous Serial Interface (ASI)

BGINT: Baud rate interrupt request from Asynchronous Serial Interface (ASI)

CSINTn (n=0,1): Transfer complete interrupt request from Clock Synchronous Serial Interface n (CSIn)

ADINT: A/D conversion complete interrupt request from Analog-to-Digital Converter (ADC)

Table 4.3 :	Interrupt So	urce Mappings			
Interrupt Source	Interrupt Number	Request Pending Flag	Interrupt Level Control Interrupt Level field in Interrupt Level Control Registers	Fixed Priority	
nEFIQ	-	EFIQR	-		-
nEIR[7]	31	IRR3[7]	ILR31	Н	igh
nEIR[6]	30	IRR3[6]	ILR30		
nEIR[5]	29	IRR3[5]	ILR29		
nEIR[4]	28	IRR3[4]	ILR28		
nEIR[3]	27	IRR3[3]	ILR27		
nEIR[2]	26	IRR3[2]	ILR26		
nEIR[1]	25	IRR3[1]	ILR25		
nEIR[0]	24	IRR3[0]	ILR24		
Reserved	23	-	-		
Reserved	22	-	-		
EVENT5	21	IRR2[5]	ILR21		
FTMOV5	20	IRR2[4]	ILR20		
EVENT4	19	IRR2[3]	ILR19		
FTMOV4	18	IRR2[2]	ILR18		
EVENT3	17	IRR2[1]	ILR17		
FTMOV3	16	IRR2[0]	ILR16		
EVENT2	15	IRR1[7]	ILR15		
FTMOV2	14	IRR1[6]	ILR14		
EVENT1	13	IRR1[5]	ILR13		
FTMOV1	12	IRR1[4]	ILR12		
EVENT0	11	IRR1[3]	ILR11		
FTMOV0	10	IRR1[2]	ILR10		
WDINT	9	IRR1[1]	ILR9		
Reserved	8	-	-		
Reserved	7	-	-		
Reserved	6	-	-		
RVINT	5	IRR0[5]	ILR5		
TRINT	4	IRR0[4]	ILR4		
BGINT	3	IRR0[3]	ILR3		
CSINT1	2	IRR0[2]	ILR2		
CSINT0	1	IRR0[1]	ILR1		ţ.
ADINT	0	IRR0[0]	ILR0	L	ow

4.3 Control Registers

4.3.1 Interrupt Number Register (INR)

The Interrupt Number Register (INR) is an 8-bit read-only register that holds the interrupt number assigned to the unmasked interrupt request with the highest priority.

After a system reset, it contains an indeterminate value.

7	6	5	4	3	2	1	0
0	0	0			IN		

A "0" indicates a reserved bit. Reading it always yields "0."

Figure 4.2 : Interrupt Number Register (INR)

Bit Descriptions

IN

This field holds the interrupt number assigned to the unmasked interrupt request with the highest priority. The hardware assigns a unique number between 0 and 31 to each source.

4.3.2 Current Interrupt Level Register (CILR)

The Current Interrupt Level Register (CILR) is an 8-bit read/write register that holds flags for the interrupt levels assigned to the interrupts currently being processed.

After a system reset, it contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 4.3 : Current Interrupt Level Register (CILR)

Bit Descriptions

The upper seven bits are interrupt level flags which tell the interrupt controller to mask interrupt requests at the same or lower interrupt level. When the Interrupt Number Register (INR) is read out, the interrupt controller sets the CILR bit corresponding to the interrupt level in the Interrupt Request Level Register (IRLR).

Writing "1" to a bit resets it to "0." Writing "0" produces no change.

The bit numbers are the same as the interrupt levels.

CILR[7]:Flag for interrupt level 7CILR[6]:Flag for interrupt level 6::CILR[1]:Flag for interrupt level 1

4.3.3 Interrupt Request Level Register (IRLR)

The Interrupt Request Level Register (IRLR) is an 8-bit read-only register that holds the interrupt level (obtained from an interrupt level field (ILRn, n=0 - 31) in the Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15)) for the unmasked interrupt request with the highest priority.

After a system reset, it contains 0x00.

7	6	5	4	3	2	1	0
0	0	0	0	0		IRL	

A "0" indicates a reserved bit. Reading it always yields "0".

Figure 4.4 : Interrupt Request Level Register (IRLR)

Bit Descriptions

IRL

This field holds the interrupt level assigned to the unmasked interrupt request with the highest priority. The interrupt controller obtains this level, a number between 1 and 7, from the interrupt level field (ILRn, n=0 - 31) in the Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15) corresponding to the source of the interrupt request.

4.3.4 External FIQ Control Register (EFIQCON)

The External FIQ Control Register (EFIQCON) is an 8-bit read/write register that notes external fast interrupt requests, tracks the signal level at the external fast interrupt request (nEFIQ) pin, and controls masking of external fast interrupt requests.

After a system reset, it contains either 0x04 or 0x06.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 4.5 : External FIQ Control Register (EFIQCON)

Bit Descriptions

EFIQM

This bit enables/disables masking of external fast interrupt requests. Setting it to "1" masks requests; a "0" allows further processing.

EFIQS

This bit tracks the signal level at the external fast interrupt request (nEFIQ) pin. A "0" indicates "L" level input; a "1," "H" level input.

EFIQR

This bit goes to "1" when the interrupt controller detects a falling edge in the signal from the nEFIQ pin. A "1" therefore indicates that one or more external fast interrupt requests have been received; a "0," that none have been received.

Writing "1" to this bit resets it to "0." Writing "0" produces no change.

4.3.5 External IRQ Control Register (EIRCON)

The External IRQ Control Register (EIRCON) is an 8-bit read/write register specifying the detection methods ("L" level sensing or falling edge sensing) for external interrupt requests from the nEIR[7:0] pins.

After a system reset, it contains 0x00.



Figure 4.6 : External IRQ Control Register (EIRCON)

Bit Descriptions

EIRn (n=0 - 7)

EIRn (n=0 - 7) controls the detection method for the external interrupt request signal from External Interrupt n pin (nEIR[n], n=0 - 7). Setting it to "1" specifies falling edge sensing; resetting it to "0," "L" level sensing. When it detects the specified input, the interrupt controller sets the corresponding bit in Interrupt Request Register 3 (IRR3) to "1."

4.3.6 Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3)

The Interrupt Request Registers 0 to 3 (IRRn, n=0-3) are 8-bit read/write registers containing numbered flags tracking external and internal interrupt requests.

After a system reset, they contain 0x00.

For the mapping between interrupt sources and IRRn bits, refer back to Table 4.3.

Writing "1" to a bit resets it to "0." Writing "0" produces no change.



Writing "1" produces unreliable operation.



Bit Descriptions

The bits in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3) are flags indicating whether there has been an interrupt request from the corresponding source. A "1" indicates that one or more interrupt requests have been received; a "0," that none have been received.

4.3.7 Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15)

The Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15) are 8-bit read/write registers specifying the interrupt levels for the individual interrupt sources.

After a system reset, they contain 0x00.

Figure 4.8 gives the locations of the interrupt level fields (ILRn, n=0-31) specified for the individual interrupt sources in Table 4.3. Setting the interrupt level to 0 masks interrupt requests from the corresponding interrupt source. Setting it to 1 enables them with the lowest priority. Higher levels represent higher priorities. Level 7 has the highest priority.

	7	6	5	4	3	2	1	0
ILCON0	0		ILR1		0		ILR0	
		1				1		
ILCON1	0		ILR3		0		ILR2	
ILCON2	0		ILR5		0		ILR4	
	0	0			0	0		0
ILCONS	0	0	0	0	0	0	0	0
ILCON4	0		ILR9		0	0	0	0
ILCON5	0		ILR11		0		ILR10	
	<u> </u>	1				1		
ILCON6	0		ILR13		0		ILR12	
ILCON7	0		ILR15		0		ILR14	
ILCON8	0		ILR17		0		ILR16	
ILCON9	0		ILR19		0		ILR18	
ILCON10	0		ILR21		0		ILR20	
ILCON11	0	0	0	0	0	0	0	0
ILCON12	0		ILR25		0		ILR24	
	·							
ILCON13	0		ILR27		0		ILR26	
ILCON14	0		ILR29		0		ILR28	
ILCON15	0		ILR31		0		ILR30	

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 4.8 : Interrupt Level Control Registers 0 to 15 (ILCONn, n=0 - 15)

4.4 Interrupt Processing

4.4.1 External Fast Interrupt Requests

If there is an external fast interrupt request and the external FIQ mask (EFIQM) flag in the External FIQ Control Register (EFIQCON) does not mask it, the interrupt controller sends the CPU an FIQ exception request.

4.4.1.1 Interrupt Sequence

(1) Interrupt arrives.

The interrupt controller detects an external fast interrupt request from the external fast interrupt request (nEFIQ) pin.

(2) Interrupt is noted.

The interrupt controller sets the EFIQR bit in the External FIQ Control Register (EFIQCON) to "1" to indicate that an external fast interrupt request has been received.

(3) Interrupt passes to CPU.

If the EFIQM flag in EFIQCON is not masking external fast interrupt requests, the interrupt controller asserts the nFIQ signal to send the CPU an FIQ exception request.

(4) CPU accepts FIQ exception.

If the CPU is accepting FIQ exception requests - that is, if the F bit in its Current Program Status Register (CPSR) is not masking them - it switches to FIQ exception handling, setting the F and I bits in CPSR to "1" to disable FIQ and IRQ exceptions.

(5) Handler processes interrupt.

In addition to the usual interrupt processing, the FIQ handler writes "1" to the EFIQR bit to clear the interrupt request flag and negate the nFIQ signal.

(6) Handler terminates.

The handler relinquishes control by executing the appropriate return instruction.

4.4.2 External and Internal Interrupt Requests

Each external and internal interrupt source has, as shown in Table 4.3, its own

- Interrupt number
- Pending flag in the Interrupt Request Registers 0 to 3 (IRRn, n=0 3)
- Interrupt level field (ILRn, n=0 31) in the Interrupt Level Control Registers 0 to 15(ILCONn, n=0 15)
- Fixed priority

4.4.2.1 Interrupt Priority Order

The interrupt controller uses the following procedure to decide interrupt priority.

- (1) If the interrupt level specified for the corresponding source is higher than the highest level flagged in the Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed, the interrupt controller asserts the IRQ signal to send the CPU an IRQ exception request.
- (2) If there are multiple interrupt requests satisfying the above condition, the interrupt controller selects the one with the highest interrupt level.
- (3) If there are multiple interrupt requests with the highest interrupt level, the interrupt controller selects the one with the highest fixed priority. The interrupt controller then writes the interrupt level assigned to the selected interrupt request to the Interrupt Request Level Register (IRLR) and the interrupt number to the Interrupt Number Register(INR).

4.4.2.2 Interrupt Sequence

(1) Interrupt arrives.

The interrupt controller detects an external interrupt request from the nEIR[7:0] pins or an internal interrupt request from the on-chip peripherals.

(2) Interrupt is noted.

The interrupt controller sets the corresponding pending flag in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3) to indicate that an interrupt request has been received.

(3) Interrupt passes to CPU.

If an interrupt level of 0 is not masking interrupt requests from that source, the interrupt controller runs through the following three steps.

• It asserts the exception signal to the CPU.

If there are any interrupt requests with interrupt levels higher than the highest level flagged in the Current Interrupt Level Register (CILR), which holds interrupt level flags for the interrupts currently being processed, the interrupt controller asserts the nIRQ signal to send the CPU an IRQ exception request.

• It determines the interrupt level.

The interrupt controller selects the highest interrupt level from among the outstanding interrupt requests and stores that level in the Interrupt Request Level Register (IRLR).

• It determines the interrupt number.

The interrupt controller selects the interrupt source with the highest priority using the procedure in Section 4.4.2.1 "Interrupt Priority Order" above and places its number in the Interrupt Number Register (INR).

(4) CPU accepts IRQ exception.

If the CPU is accepting IRQ exception requests - that is, if the I bit in its Current Program Status Register (CPSR) is not masking them - it switches to IRQ exception handling, setting the I bit in CPSR to "1" to disable IRQ exceptions.

(5) Handler distinguishes between interrupts.

The IRQ handler reads the interrupt number from the interrupt controller's Interrupt Number Register (INR). In response to this read, the interrupt controller sets the CILR bit corresponding to the interrupt level assigned to that interrupt source and negates the nIRQ signal.

(6) Handler processes interrupt.

In addition to the usual interrupt processing, the IRQ handler

• Enables IRQ exceptions.

To allow interrupt requests with higher interrupt levels to interrupt it, the handler saves the Link Register (R14_irq) and the Saved Program Status Register (SPSR_irq) to the stack and then resets the I bit in CPSR to "0" to enable IRQ exceptions.

· Clears the interrupt request.

The handler writes "1" to the corresponding pending flag in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3) to clear the interrupt request.

(7) Handler terminates.

The handler resets the CILR bit corresponding to the interrupt level assigned to the interrupt source to "0" and then relinquishes control by executing the appropriate return instruction.

4.4.2.3 Example of Interrupt Level Control

Figure 4.9 gives an example of a level 7 interrupt interrupting processing of a level 2 interrupt and then itself being interrupted by an FIQ exception.

t1. Level 2 interrupt arrives.

The interrupt controller sets the Interrupt Request Level Register (IRLR) to 2 and asserts the nIRQ signal to send the CPU an IRQ exception request.

t2. CPU accepts IRQ exception.

Control passes to the IRQ handler.

t3. IRQ handler reads INR.

The IRQ handler reads the interrupt number from the interrupt controller's Interrupt Number Register (INR). In response to this read, the interrupt controller sets bit 2 in the Current Interrupt Level Register (CILR[2]) to "1" and negates the nIRQ signal.

t4. IRQ handler processes level 2 interrupt.

To enable interrupt requests with higher interrupt levels, the IRQ handler saves the Link Register (R14_irq) and the Saved Program Status Register (SPSR_irq) to the stack and then resets the I bit in CPSR to "0."

t5. Level 7 interrupt arrives.

The interrupt controller sets IRLR to 7 and asserts the nIRQ signal to send the CPU an IRQ exception request.

t6. CPU accepts IRQ exception.

Control passes to the IRQ handler.

t7. IRQ handler reads INR.

The IRQ handler reads the interrupt number from INR. Because IRLR contains 7, the interrupt controller sets CILR[7] to "1" and negates the nIRQ signal.

- t8. IRQ handler processes level 7 interrupt.
- t9. Fast interrupt request arrives.

The interrupt controller asserts the nFIQ signal to send the CPU an FIQ exception request.

t10. CPU accepts FIQ exception.

Control passes to the FIQ handler.

t11. FIQ handler clears EFIQR.

The FIQ handler writes "1" to the EFIQR bit to clear the interrupt request flag and negate the nFIQ signal.

t12. FIQ handler terminates.

The FIQ handler executes the SUBS PC,R14_fiq,#4 instruction to return control to processing of the level 7 interrupt, interrupted by the FIQ exception.

t13. IRQ handler clears level 7 interrupt request.

The IRQ handler writes "1" to the pending flag corresponding to the current interrupt source in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3) to clear the interrupt request.

t14. IRQ handler clears CILR[7].

Just before terminating level 7 interrupt processing, the IRQ handler clears CILR[7].

t15. IRQ handler terminates.

The IRQ handler executes the SUBS PC,R14_irq,#4 instruction to return control to processing of the level 2 interrupt, interrupted by the level 7 interrupt.

t16. IRQ handler clears level 2 interrupt request.

The IRQ handler writes "1" to the pending flag corresponding to the current interrupt source in the Interrupt Request Registers 0 to 3 (IRRn, n=0 - 3) to clear the interrupt request.

Note : Before executing steps t17 and t18, the IRQ handler must set the I bit in CPSR to "1" to disable IRQ exceptions.

t17. IRQ handler clears CILR[2].

Just before terminating level 2 interrupt processing, the IRQ handler clears CILR[2].

t18. IRQ handler terminates.

The IRQ handler restores the saved Link Register (R14_irq) and Saved Program Status Register (SPSR_irq) from the stack and executes the SUBS PC,R14_irq,#4 instruction to return control to regular processing, interrupted by the level 2 interrupt.



Figure 4.9 : Example of Interrupt Level Control

4.5 Sampling Timing for External Interrupt Requests

The interrupt controller samples the external fast interrupt request signal from the nEFIQ pin and the external interrupt request signals from the nEIR[7:0] pins and sets the corresponding interrupt request bits to "1" when it detects input.

Figure 4.10 shows the timing with which the interrupt controller samples the external fast interrupt request signal from the nEFIQ pin and sets the EFIQR bit in the External FIQ Control Register (EFIQCON) to "1."

The interrupt controller samples the nEFIQ input at the rising edges of the system clock (SYSCLK) signal. A transition from "H" level to "L" level over the sampling interval causes the interrupt controller, at the next SYSCLK rising edge, to set the EFIQR bit to "1" and send the CPU an FIQ exception request.

The nEFIQ input signal must have "H" level and "L" level pulses that are at least two system clock (SYSCLK) cycles long.



Figure 4.10 : Sampling Timing for External Fast Interrupt Requests

Figure 4.11 shows the timing with which the interrupt controller samples the external interrupt request signal from External Interrupt n pin (nEIR[n], n=0 - 7) and sets the corresponding pending flag in Interrupt Request Register 3 (IRR3) to "1."

The interrupt controller samples the nEIR[n] input at the rising edges of the system clock (SYSCLK) signal. If the corresponding bit in the External IRQ Control Register (EIRCON) specifies falling edge sensing for interrupt request detection, a transition from "H" level to "L" level over the sampling interval causes the interrupt controller to set the corresponding pending flag in IRR3 to "1" at the next SYSCLK rising edge and send the CPU an IRQ exception request.

If that bit specifies "L" level sensing, "L" level input causes the interrupt controller to set the corresponding pending flag in IRR3 to "1" at the next SYSCLK rising edge and send the CPU an IRQ exception request. The interrupt controller continues setting that bit as long as sampling detects "L" level input.

The nEIR[n] (n=0 - 7) input signal must have "H" level and "L" level pulses that are at least two system clock (SYSCLK) cycles long.



(b) Using "L" level sensing for interrupt request detection

Figure 4.11 : Sampling Timing for External Interrupt Requests

4.6 Interrupt Response Times

Table 4.4 indicates the number of clock cycles between the arrival of an interrupt and the start of the fetch cycle for the instruction at the vector address.

Note that even if an interrupt has set the corresponding interrupt request flag, there are two cases when it does not produce an immediate FIQ or IRQ exception.

- The interrupt controller is masking the interrupt.
- The interrupt has a level less than or equal to that of the interrupt currently being processed.

The interrupt controller does not generate an interrupt request to the CPU until both conditions no longer apply.

The CPU ignores such requests until both the F or I bit in the Current Program Status Register (CPSR) is "0."

Table 4.4 : Ii	nterrupt Res	ponse Times				
		Clock	Notes			
Step		Interrupt from external	Interrupt from external Interrupt from internal			
		source	source			
Delay between	application of	2	-			
signal to pin ar	nd raising of					
interrupt reque	st flag					
Wait for curren	nt instruction	X (Mini	mum: 1)	For instructions in internal		
to complete ex	ecution			memory, the minimum wait is		
			one clock cycle. The worst case			
			takes 20 clock cycles: an LDM			
			instruction loading all 16			
				general-purpose registers.		
Time required	to save the PC	21	M is the length of the			
and CPSR regi	sters and load		instruction's fetch cycle - one			
the vector addr	ess		clock cycle for instructions in			
			internal memory.			
			Before fetching the instruction at			
			the vector address, the LSI			
				performs two dummy fetch		
			-	operations.		
Interrupt	Total	X+2M+2	X+2M			
response time	Minimum	5	3			

4.7 Notes on Processing Interrupts

1. Reading interrupt number register (INR)

Read the contents of this register only once per IRQ exception because they are invalid between the first read and the next interrupt request.

2. Reading interrupt request level register (IRLR)

The IRQ handler must read this register before the interrupt number register (INR) because reading the latter resets the contents to 0x00.

3. Processing invalid interrupt requests

In the interval between when the CPU accepts an IRQ exception request and when it transfers control to the IRQ handler, the following actions trigger spurious interrupt requests that invalidate the contents of both the interrupt number (INR) and interrupt request level (IRLR) registers.

- Setting the interrupt request's interrupt level lower than the current interrupt level.
- Masking the interrupt request by setting its interrupt level to zero.
- Clearing the interrupt request by setting its interrupt request flag in the interrupt request registers (IRR0 and IRR1) to "0."

These spurious interrupt requests reset both the interrupt number (INR) and interrupt request level (IRLR) registers to 0x00. They do not affect the contents of the current interrupt level register (CILR).

If the user application program changes interrupt levels or clears interrupt requests outside the IRQ handler and initialization routine, therefore, the IRQ handler must incorporate the following logic to detect these spurious interrupt requests.

- (1) Read the contents of the interrupt request level register (IRLR).
- (2) If the contents are 0x00, return from the IRQ handler.

If the IRLR contents are not 0x00, it is safe for the IRQ handler to read the contents of the interrupt number register (INR) and continue.

If changing the interrupt level produces a spurious interrupt request, there is an IRQ exception request when that interrupt's interrupt level becomes higher than the current interrupt level.
5 I/O Ports

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5.1 Overview

The I/O ports consist of nine 8-bit ports: PIOn (n=0 - 8). I/O directions are specified at the bit level. When configured for input, the pins use high-impedance input.

In addition to their primary functions as I/O ports, some pins have secondary functions as extensions to the external bus and as I/O pins for the on-chip peripherals. The I/O directions for pins configured for these secondary functions depend of the settings and operation of the corresponding on-chip peripheral. Table 5.1 lists these secondary functions and I/O directions.

A system reset triggered by the external reset signal (nRST) initializes PIOn pin functions to the following configurations:

- PIO2[7] and PIO3 to PIO7 have their primary pin functions (I/O) and are configured for input.
- All other I/O port 2 pins (PIO2[6:0]) have their secondary functions.
- PIO0 and PIO1 have the functions determined by the input levels during the reset at the nEA and DBSEL pins, respectively.
- PIO8 has the functions determined by the input level of the TEST pin during the reset.
 - "L" level (GND) input configures the pins as I/O pins
 - "H" level (VDD) input configures the pins as the debugging interface

A system reset triggered by the Watchdog Timer (WDT) counter overflow signal (WDTOV) does not affect pin functions. They remain as they were before the reset.

Port Pin(s)	Signal Name(s)	Direction	System reset by nRST
PIO0[7:0]	XA23 - 16	Output	Depends on the nEA pin
			setting *1
PIO1[7:0]	XD15 - 8	Bi-directional	Depends on the DBSEL pin
			setting *2
PIO2[7]	nXWAIT	Input	Primary function
PIO2[6]	nCS1	Output	Secondary function
PIO2[5]	nHB/nWRH	Output	Secondary function
PIO2[4]	nRAS1	Output	Secondary function
PIO2[3]	nWH/nCASH	Output	Secondary function
PIO2[2]	nRAS0	Output	Secondary function
PIO2[1]	nCAS/nCASL	Output	Secondary function
PIO2[0]	nWL/nWE	Output	Secondary function
PIO3[7:0]	nEIR[7:0]	Input	Primary function
PIO4[7:6]	TMCLK[1:0]	Input	Primary function
PIO4[5:0]	TMIN[5:0]/TMOUT[5:0]	Bi-directional	Primary function

Table 5.1 : Secondary Functions for I/O Port Pins

*1 nEA pin = L level : Secondary function (external address bus)

nEA pin = H level : Primary function (I/O pins)

*2 DBSEL pin = L level : Primary function (I/O pins)

DBSEL pin = H level : Secondary function (external data bus)

Table 5.1 : Secondary Functions for I/O Port Pins									
Port Pin(s)	Signal Name(s)	Direction	System reset by nRST						
PIO5[7]	ASI_TXD	Output	Primary function						
PIO5[6]	ASI_RXD	Input	Primary function						
PIO5[5]	CSI1_TXD	Output	Primary function						
PIO5[4]	CSI1_RXD	Input	Primary function						
PIO5[3]	CSI1_SCLK	Bi-directional	Primary function						
PIO5[2]	CSI0_TXD	Output	Primary function						
PIO5[1]	CSI0_RXD	Input	Primary function						
PIO5[0]	CSI0_SCLK	Bi-directional	Primary function						
PIO6[7:0]	None	-	-						
PIO7[7]	nBACK	Output	Primary function						
PIO7[6]	nBREQ	Input	Primary function						
PIO7[5:0]	None	-	-						
PIO8[7]	TDI	Input	Depends on the TEST pin						
PIO8[6]	TDO	Output	setting *3						
PIO8[5]	nTRST	Input							
PIO8[4]	TMS	Input							
PIO8[3]	ТСК	Input							
PIO8[2]	DBGEN	Input							
PIO8[1]	DBGRQ	Input							
PIO8[0]	DBGACK	Output							

Table 5 1 · Sc dary Eurotions for I/O Port Pi

*3

TEST pin = L level : Primary function (I/O pins) TEST pin = H level : Secondary function (debugging interface)

5.1.1 Control Registers

Table 5.2 lists the control registers for the I/O ports.

Table	52:	I/O	Port	Control	Registers
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Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0600	Port Output Register 0	PO0	R/W	8	Indeterminate
0x060_0601	Port Output Register 1	PO1	R/W	8	Indeterminate
0x060_0602	Port Output Register 2	PO2	R/W	8	Indeterminate
0x060_0603	Port Output Register 3	PO3	R/W	8	Indeterminate
0x060_0604	Port Output Register 4	PO4	R/W	8	Indeterminate
0x060_0605	Port Output Register 5	PO5	R/W	8	Indeterminate
0x060_0606	Port Output Register 6	PO6	R/W	8	Indeterminate
0x060_0607	Port Output Register 7	PO7	R/W	8	Indeterminate
0x060_0608	Port Output Register 8	PO8	R/W	8	Indeterminate
0x060_0610	Port Input Register 0	PIO	R	8	Indeterminate
0x060_0611	Port Input Register 1	PI1	R	8	Indeterminate
0x060_0612	Port Input Register 2	PI2	R	8	Indeterminate
0x060_0613	Port Input Register 3	PI3	R	8	Indeterminate
0x060_0614	Port Input Register 4	PI4	R	8	Indeterminate
0x060_0615	Port Input Register 5	PI5	R	8	Indeterminate
0x060_0616	Port Input Register 6	PI6	R	8	Indeterminate
0x060_0617	Port Input Register 7	PI7	R	8	Indeterminate
0x060_0618	Port Input Register 8	PI8	R	8	Indeterminate
0x060_0620	Port Mode Register 0	PM0	R/W	8	0x00
0x060_0621	Port Mode Register 1	PM1	R/W	8	0x00
0x060_0622	Port Mode Register 2	PM2	R/W	8	0x00
0x060_0623	Port Mode Register 3	PM3	R/W	8	0x00
0x060_0624	Port Mode Register 4	PM4	R/W	8	0x00
0x060_0625	Port Mode Register 5	PM5	R/W	8	0x00
0x060_0626	Port Mode Register 6	PM6	R/W	8	0x00
0x060_0627	Port Mode Register 7	PM7	R/W	8	0x00
0x060_0628	Port Mode Register 8	PM8	R/W	8	0x00
0x060_0630	Port Function Selection Register 0	PFS0	R/W	8	0x00/FF
0x060_0631	Port Function Selection Register 1	PFS1	R/W	8	0x00/FF
0x060_0632	Port Function Selection Register 2	PFS2	R/W	8	0x7F
0x060_0633	Port Function Selection Register 3	PFS3	R/W	8	0x00
0x060_0634	Port Function Selection Register 4	PFS4	R/W	8	0x00
0x060_0635	Port Function Selection Register 5	PFS5	R/W	8	0x00
0x060_0637	Port Function Selection Register 7	PFS7	R/W	8	0x00

5.2 Control Registers

5.2.1 Port Output Registers 0 to 8 (POn, n=0 - 8)

Port Output Register n (POn, n=0 - 8) is an 8-bit read/write register that holds the output data for I/O port PIOn. If the corresponding PIOn pin is configured for I/O port output (not secondary), the POn bit controls the pin output level. Setting that POn bit to "1" then produces "H" level output; resetting it to "0," "L" level output.

After a system reset, this register contains an indeterminate value.

7	6	5	4	3	2	1	0

Figure 5.1	: Port Output	Registers 0	to 8 (POr	n. n=0 - 8)
				.,,

5.2.2 Port Input Registers 0 to 8 (PIn, n=0 - 8)

Port Input Register n (PIn, n=0 - 8) is an 8-bit read-only register that holds the input data from I/O port PIOn. If the corresponding PIOn pin is configured for input (primary or secondary function), the PIn bit gives the pin input level. If the pin is configured for output (primary or secondary function), the PIn bit gives the pin output level. A "0" indicates "L" level; a "1," "H" level.

After a system reset, this register contains an indeterminate value.

7	6	5	4	3	2	1	0

Figure 5.2 : Port Input Registers 0 to 8 (POn, n=0 - 8)

Note : For further details, see Section 5.3.2 "Reading from I/O Ports."

5.2.3 Port Mode Registers 0 to 8 (PMn, n=0 - 8)

Port Mode Register n (PMn, n=0 - 8) is an 8-bit read/write register that specifies the I/O directions for I/O port PIOn pins.

These settings apply only to the primary function, I/O ports.

A system reset triggered by the external reset signal (nRST) clears all these registers to 0x00.

7	6	5	4	3	2	1	0

Figure 5.3 : Port Mode Registers 0 to 8 (PMn, n=0 - 8)

Bit Descriptions

The bits in Port Mode Register n (n=0-8) control the I/O directions of the corresponding pins in I/O port n. Setting a bit to "1" configures the pin for output; resetting it to "0," for input.

5.2.4 Port Function Selection Registers 0 to 5, 7(PFSn, n=0 - 5, 7)

Port Function Selection Register n (PFSn, n=0 - 5, 7) is an 8-bit read/write register containing control bits for activating secondary functions for the corresponding PIOn pins.

(1) Port Function Selection Register 0 (PFS0)

Port Function Selection Register 0 (PSF0) activates PIO0 pin secondary (XA pin) functions at the bit level. After a system reset triggered by the external reset signal (nRST), each bit has a value that depends on the nEA input level during the reset. "L" level input sets them to "1" (PSF0 = 0xFF), and the PIO0 pins function as external address bus pins XA23 to XA16; "H" level input sets them to "0" (PSF0 = 0x00), and the pins function as an I/O port.

In the former case, the program can restrict the number of pins used for the external address bus XA by setting this register to the proper masking value for specifying the number of bits in the address.

XA16 only	$PSF0 = 8'b0000_{0001}$
XA17 and XA16	PSF0 = 8'b0000_0011
::	
XA23 to XA16	PSF0 = 8'b1111 1111



Figure 5.4 : Port Function Selection Register 0 (PFS0)

Bit Descriptions

The bits in PFS0 control the secondary pin functions for I/O port PIO0. Setting a bit to "1" configures the corresponding pin as part of the external address bus XA; resetting it to "0," as an I/O pin.

(2) Port Function Selection Register 1 (PFS1)

Port Function Selection Register 1 (PFS1) activates PIO1 pin secondary (XD pin) functions together as a single group. Do not set the register to a value other than 0x00 or 0xFF. Doing so produces unreliable operation.

After a system reset triggered by the external reset signal (nRST), each bit has a value that depends on the DBSEL input level during the reset. "L" level (GND) input sets them to "0" (PSF1 = 0x00), and the PIO1 pins function as an I/O port; "H" level (V DD) input sets them to "1" (PSF1 = 0xFF), and the pins function as external data bus pins XD15 to XD8.

7	6	5	4	3	2	1	0

Figure 5.5 : Port Function Selection Register 1 (PFS1)

Bit Descriptions

The bits in PFS1 control the secondary pin functions for I/O port PIO1. Setting a bit to "1" configures the corresponding pin as part of the external data bus XD; resetting it to "0," as an I/O pin.

(3) Port Function Selection Register 2 to 5 (PFS, n=2 - 5)

Port Function Selection Register n (PFSn, n=2 - 5) activates PIOn pin secondary functions at the bit level.

After a system reset triggered by the external reset signal (nRST), PFS2 contains 0x7F and PFS3 to PFS5 contain 0x00.



Figure 5.6 : Port Function Selection Register n (PFSn, n=2 - 5)

Bit Descriptions

The bits in PFSn (n=2 - 5) control the secondary pin functions for I/O port PIOn. Setting a bit to "1" configures the corresponding pin for its secondary function; resetting it to "0," as an I/O pin.

(4) Port Function Selection Register 7 (PFS7)

Port Function Selection Register 7 (PFS7) activates PIO7 pin secondary functions at the bit level.

After a system reset triggered by the external reset signal (nRST), this register contains 0x00.

7	6	5	4	3	2	1	0
		0	0	0	0	0	0

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 5.7 : Port Function Selection Register 7 (PFS7)

Bit Descriptions

The bits in PFS7 control the secondary pin functions for I/O port PIO7. Setting a bit to "1" configures the corresponding pin for its secondary function; resetting it to "0," as an I/O pin.

5.3 I/O Port Operation

5.3.1 Configuration after System Reset

A system reset triggered by the external reset signal (nRST) initializes PIOn pin functions to the following configurations:

- PIO2[7] and PIO3 to PIO7 have their primary pin functions (I/O) and are configured for input.
- All other I/O port 2 pins (PIO2[6:0]) have their secondary functions.
- PIO0, PIO1, and PIO8 have the functions determined by the input levels during the reset at the nEA, DBSEL, and TEST pins, respectively.

A system reset triggered by the Watchdog Timer (WDT) counter overflow signal (WDTOV) does not affect pin functions. They remain as they were before the reset.

5.3.2 Reading from I/O Ports

The meanings of the bits obtained by reading the Port Input Register n (PIn, n=0-8) depend on the configurations of the corresponding pins as shown in Table 5.3.

Function	Direction	Value returned
	Direction	Valacifica
Primary	Input	Input level at the pin
	Output	Output level at the pin (See Note 1.)
Secondary	Input	Input level at the pin (See Note 2.)
	Output	Output level at the pin

Table 5.3 : Reading from I/O Ports

Note :

- 1. Here, the PIn bit is equal to the corresponding POn bit because the latter controls the output level.
- 2. Here, PIO0 to PIO2 return indeterminate values.

5.3.3 Writing to I/O Ports

If an I/O port n (PIOn, n=0 - 8) pin is configured for I/O port output (not secondary), its output level reflects the corresponding bit in Port Output Register n (POn, n=0 - 8). If it is configured for its secondary function, the output is the output from the corresponding on-chip peripheral.

6 Time Base Generator

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6.1 Overview

The main components of the Time Base Generator (TBG) are the Time Base Counter (TBC), a frequency divider which derives the time base clock signals for the on-chip peripherals from the system clock (SYSCLK) signal, and the Watchdog Timer (WDT), which counts time base clock cycles and produces a system reset signal (WDTOV) when its internal counter overflows.

The Time Base Counter (TBC) starts at 0 after a system reset and continues counting as long as it receives the system clock (SYSCLK) signal.

The Watchdog Timer (WDT) starts off inoperative after a system reset.

6.1.1 Block Diagram

Figure 6.1 gives a block diagram for the Time Base Generator (TBG), which includes the following components:

- Time Base Counter (TBC), a frequency divider which derives the time base clock signals from the system clock (SYSCLK) signal
- Watchdog Timer (WDT), which counts time base clock cycles and prevents runaway operation
- Time Base Generator Control Register (TBGCON), which controls Time Base Generator (TBG) operation
- Watchdog Timer Control Register (WDTCON), which the program uses to start and periodically reset the Watchdog Timer (WDT)



WDTOV: System reset signal upon Watchdog timer overflow WDINT: Watchdog timer interrupt request signal



6.1.2 Control Registers

Table 6.1 lists the control registers for the Time Base Generator (TBG).

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0200	Watchdog Timer Control Register	WDTCON	W	8	Stopped
0x060_0201	Time Base Generator Control Register	TBGCON	R/W	8	0x00

Table 6.1 : Time Base Generator (TBG) Control Registers

6.2 Control Registers

6.2.1 Watchdog Timer Control Register (WDTCON)

The Watchdog Timer Control Register (WDTCON) is an 8-bit write-only register for starting the Watchdog Timer (WDT) and clearing it to 0. In its watchdog timer configuration, writing 0x3C to this register starts the WDT internal counter and then alternately writing 0xC3 and 0x3C clears that counter.

In its interval timer configuration, the first write of 0x3C to this register starts the counter, and subsequent writes of the same value clear the counter.

7	6	5	4	3	2	1	0

Figure 6.2 : Watchdog Timer Control Register (WDTCON)

6.2.2 Time Base Generator Control Register (TBGCON)

The Time Base Generator Control Register (TBGCON) is an 8-bit read/write register that controls Time Base Generator (TBG) operation. After a system reset, this register contains 0x00, which selects 32TBCCLK as the Watchdog Timer (WDT) count clock.

Modifying this register requires two operations: writing 0x5A and then writing the new value. Without the first, the second is ignored. Writing the new value into this register automatically clears the WDT internal counter to 0.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 6.3 : Time Base Generator Control Register (TBGCON)

Bit Descriptions

Note Writing to any of the ITEN, ITM, and WDCK bits automatically resets the WDT internal counter to 0.

ITEN

This bit is only used when a "1" in the ITM bit configures the Watchdog Timer (WDT) as an interval timer.

A "0" in this bit disables the interval timer. Writing "1" to this bit enables the timer. Writing 0x3C to the Watchdog Timer Control Register (WDTCON) then starts the timer. If the interval timer is counting up, writing 0x3C to WDTCON resets the WDT internal counter to 0.

ITM

This bit specifies the operating mode for the Watchdog Timer (WDT). A "0" configures the timer as a normal watchdog timer; a "1," as an interval timer.

WDCKS

This field specifies the Watchdog Timer (WDT) count clock. The selections available consist of the following four Time Base Counter (TBC) outputs: 32TBCCLK, 64TBCCLK, 128TBCCLK, and 256TBCCLK.

6.3 Time Base Generator (TBG) Operation

6.3.1 Time Base Counter (TBC)

The Time Base Counter (TBC) is a frequency divider which derives the time base clock signals for the on-chip peripherals from the system clock (SYSCLK) signal. Figure 6.4 shows the relationships between the system clock (SYSCLK) signal and these outputs, 2TBCCLK to 256TBCCLK. These outputs synchronize their rising edges with the SYSCLK falling edges. Their frequencies are the system clock (SYSCLK) frequency divided by powers of two.

During a system reset of this LSI, the outputs are all "0."



Figure 6.4 : System Clock (SYSCLK) and Time Base Clock Signals

6.3.2 Watchdog Timer (WDT)

The Watchdog Timer (WDT) is a 12-bit counter that counts pulses from an input clock in the range 32TBCCLK to 256TBCCLK. Although it is possible to indirectly clear the contents to 0 by writing to the Watchdog Timer Control Register (WDTCON), the contents are otherwise inaccessible to reads and writes.

After a system reset, the Watchdog Timer (WDT) is stopped.

In addition to the usual function of producing a system reset signal (WDTOV) upon counter overflow, the Watchdog Timer (WDT) can also be configured as an interval timer.

In its watchdog timer configuration, writing 0x3C to WDTCON starts the WDT internal counter and then alternately writing 0xC3 and 0x3C clears the WDT internal counter.

Not clearing the internal counter in time to prevent counter overflow generates a system reset signal (WDTOV).

The Watchdog Timer (WDT) continues operating in HALT mode. To stop it, write "1" to the ITM bit in the Time Base Generator Control Register (TBGCON) and "0" to the ITEN bit before switching to HALT mode. These settings switch the timer to its interval timer configuration and disable the internal counter. Writing "0" to the ITM bit switches the timer back to its watchdog timer configuration and starts the internal counter counting from 0.

In its interval timer configuration, writing "1" to the ITM and ITEN bits in TBGCON enables the interval timer and writing 0x3C to WDTCON then starts the WDT internal counter. Subsequent writes of 0x3C to WDTCON reset the WDT internal counter to 0.

In its interval timer configuration, counter overflow does not generate a system reset signal (WDTOV), but a Watchdog Timer (WDT) interrupt request signal (WDINT).

Figure 6.5 gives the basic structure of the Watchdog Timer (WDT).



Figure 6.5 : Watchdog Timer (WDT) Structure

6.3.3 Time to Overflow

If f is the system clock (SYSCLK) frequency in MHz, t WDT, the time in microseconds that the Watchdog Timer (WDT) internal counter takes to overflow, is given by the following formula.

t WDT = m x 4096 / f [us]

where m is the number from the clock input name - 32 from 32TBCCLK, etc.

Because clearing the Watchdog Timer (WDT) internal counter does not affect the contents of the Time Base Counter (TBC), there is a maximum negative error of one input clock cycle.

delta WDT = m / f[us]

For a system clock (SYSCLK) frequency of 16 MHz and an input clock of 256TBCCLK (m = 256), these two formulas yield the following results.

t WDT = 65.536 ms

delta WDT = 16 [us]

6.3.4 WDT Watchdog Timer Operation

Figure 6.6 illustrates WDT watchdog timer operation for a program operating normally (a) and one that runs out of control (b).

Figure 6.7 gives three possible patterns for runaway programs.



Figure 6.6 : WDT Watchdog Timer Operation



Figure 6.7 : Patterns for Runaway Programs

6.3.5 WDT Interval Timer Operation

Figure 6.8 illustrates WDT interval timer operation. Counter overflow produces a Watchdog Timer (WDT) interrupt request signal (WDINT).



7 Flexible Timer

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7.1 Overview

The Flexible Timer (FTM) consists of six 16-bit timer channels. Each channel offers independent choices of four operating modes and of eight count clocks.

- Timer operating modes
 - Auto-reload timer (ART)
 - Compare out (CMO)
 - Pulse width modulation (PWM)
 - Capture (CAP)
- Timer synchronization
 - Timer channels can be started and stopped in unison.
- External clocks
 - Timer channels 0 and 1 accept external clock signals.

7.1.1 Block Diagram

Figure 7.1 gives a block diagram for the Flexible Timer (FTM), which includes the following components:

- Timer Control Registers 0 to 5 (TMnCON, n=0 5), which control the operation of the individual timer channels
- Timer Status Registers 0 to 5 (TMnST, n=0 5), which contain flags noting overflow, compare matches, and capture events
- Timer Counters 0 to 5 (TMnC, n=0 5), which perform the counting for the individual timer channels
- Timer Registers 0 to 5 (TMnR, n=0 5), which hold the reload values for the timer counter channels
- Timer General-Purpose Registers 0 to 5 (TMnGR, n=0 5), which hold the comparison value or counter value for an event
- Timer Enable and Disable Registers (TMEN and TMDIS) for starting and stopping timer channels
- Comparators for comparing a Timer Counter (TMnC) with the corresponding Timer General-Purpose Register (TMnGR)



FTMOVn (n=0 - 5):Timer overflow interrupt request from Flexible Timer (FTM) channel n EVENTn (n=0 - 5):Capture event or compare match interrupt request from Flexible Timer (FTM) cannel n

Figure 7.1 : Block Diagram for Flexible Timer (FTM)

7.1.2 Pins

Table 7.1 lists the pins connected to the Flexible Timer (FTM).

		.,	
Pin Name	Symbol	Direction	Description
Timer Input/Output	TMIN[5:0]/ TMOUT[5:0]	Input or output	These pins function as capture trigger input pins when the corresponding timer channels are in capture (CAP) mode and as output pins when the timer channels are in compare out (CMO) or pulse width modulation (PWM) mode. They represent secondary functions for I/O port PIO4[5:0].
Timer clock input	TMCLK[1:0]	Input	These pins function as timer channel 1 and 0 clock input pins. They represent secondary functions for I/O port PIO4[7:6].

Table 7.1 : Flexible Timer (FTM) Pins

7.1.3 Control Registers

Table 7.2 lists the control registers for the Flexible Timer (FTM).

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0100	Timer Control Register 0	TM0CON	R/W	8	0x00
0x060_0101	Timer Status Register 0	TM0ST	R/W	8	0x00
0x060_0102	Timer Counter 0	TM0C	R/W	16	0x0000
0x060_0104	Timer Register 0	TM0R	R/W	16	0x0000
0x060_0106	Timer General-Purpose Register 0	TM0GR	R/W	16	0x0000
0x060_0108	Timer I/O Level Register 0	TM0IOLV	R/W	8	0x00
0x060_0109	Timer Output Register 0	TM0OUT	R/W	8	0x00
0x060_0110	Timer Control Register 1	TM1CON	R/W	8	0x00
0x060_0111	Timer Status Register 1	TM1ST	R/W	8	0x00
0x060_0112	Timer Counter 1	TM1C	R/W	16	0x0000
0x060_0114	Timer Register 1	TM1R	R/W	16	0x0000
0x060_0116	Timer General-Purpose Register 1	TM1GR	R/W	16	0x0000
0x060_0118	Timer I/O Level Register 1	TM1IOLV	R/W	8	0x00
0x060_0119	Timer Output Register 1	TM1OUT	R/W	8	0x00
0x060_0120	Timer Control Register 2	TM2CON	R/W	8	0x00
0x060_0121	Timer Status Register 2	TM2ST	R/W	8	0x00
0x060_0122	Timer Counter 2	TM2C	R/W	16	0x0000
0x060_0124	Timer Register 2	TM2R	R/W	16	0x0000
0x060_0126	Timer General-Purpose Register 2	TM2GR	R/W	16	0x0000
0x060_0128	Timer I/O Level Register 2	TM2IOLV	R/W	8	0x00
0x060_0129	Timer Output Register 2	TM2OUT	R/W	8	0x00

Table 7.2 : Flexible Timer (FTM) Control Registers

Table 7.2 : F	Flexible Timer (FTM) Control Re	egisters			
Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0130	Timer Control Register 3	TM3CON	R/W	8	0x00
0x060_0131	Timer Status Register 3	TM3ST	R/W	8	0x00
0x060_0132	Timer Counter 3	TM3C	R/W	16	0x0000
0x060_0134	Timer Register 3	TM3R	R/W	16	0x0000
0x060_0136	Timer General-Purpose Register 3	TM3GR	R/W	16	0x0000
0x060_0138	Timer I/O Level Register 3	TM3IOLV	R/W	8	0x00
0x060_0139	Timer Output Register 3	TM3OUT	R/W	8	0x00
0x060_0140	Timer Control Register 4	TM4CON	R/W	8	0x00
0x060_0141	Timer Status Register 4	TM4ST	R/W	8	0x00
0x060_0142	Timer Counter 4	TM4C	R/W	16	0x0000
0x060_0144	Timer Register 4	TM4R	R/W	16	0x0000
0x060_0146	Timer General-Purpose Register 4	TM4GR	R/W	16	0x0000
0x060_0148	Timer I/O Level Register 4	TM4IOLV	R/W	8	0x00
0x060_0149	Timer Output Register 4	TM4OUT	R/W	8	0x00
0x060_0150	Timer Control Register 5	TM5CON	R/W	8	0x00
0x060_0151	Timer Status Register 5	TM5ST	R/W	8	0x00
0x060_0152	Timer Counter 5	TM5C	R/W	16	0x0000
0x060_0154	Timer Register 5	TM5R	R/W	16	0x0000
0x060_0156	Timer General-Purpose Register 5	TM5GR	R/W	16	0x0000
0x060_0158	Timer I/O Level Register 5	TM5IOLV	R/W	8	0x00
0x060_0159	Timer Output Register 5	TM5OUT	R/W	8	0x00
0x060_0160	Timer Enable Register	TMEN	R/W	8	0x00
0x060_0161	Timer Disable Register	TMDIS	W	8	0x00

7.2 Control Registers

7.2.1 Timer Control Registers 0 to 5 (TMnCON, n=0 - 5)

Timer Control Register n (TMnCON, n=0 - 5) is an 8-bit read/write register that specifies the operating mode and count clock for Flexible Timer (FTM) channel n.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.2 : Timer Control Registers 0 to 5 (TMnCON, n=0 - 5)

Bit Descriptions

MOD

This field specifies the operating mode for timer channel n. There are four choices: auto-reload timer (ART), compare out (CMO), pulse width modulation (PWM), and capture (CAP).

TMCLK

This field specifies the count clock for Timer Counter n (TMnC, n=0-5). Timer channels 0 and 1 offer a choice of the system clock (SYSCLK) signal, time base clock signals 2TBCCLK to 32TBCCLK from the Time Base Generator (TBG), and external clock signals; timer channels 2 to 5, a choice of the system clock (SYSCLK) signal and time base clocks 2TBCCLK to 128TBCCLK.

7.2.2 Timer Status Registers 0 to 5 (TMnST, n=0 - 5)

Timer Status Register n (TMnST, n=0 - 5) is an 8-bit read/write register that contains flags noting overflow, compare matches, and capture events for Flexible Timer (FTM) channel n.

Writing "1" to a bit resets it to "0." Writing "0" produces no change.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.3 : Timer Status Registers 0 to 5 (TMnST, n=0 - 5)

Bit Descriptions

CM/CAPEV

This flag indicates events as defined by the operating mode:

- The auto-reload timer (ART) and pulse width modulation (PWM) modes do not modify this flag.
- Compare out (CMO) mode sets it to "1" and generates an interrupt request (EVENTn, n=0 5) when the contents of Timer Counter n (TMnC, n=0 5) match those of Timer General-Purpose Register n (TMnGR, n=0 5).
- Capture (CAP) mode sets it to "1" and generates an interrupt request (EVENTn, n=0 5) when it receives an event from Timer Input n pin (TMIN[n], n=0 5).

OVF

This flag indicates Timer Counter n (TMnC, n=0 - 5) overflow.

Counter overflow always sets it to "1" regardless of the timer channel's operating mode.

7.2.3 Timer Counters 0 to 5 (TMnC, n=0 - 5)

Timer Counter n (TMnC, n=0-5) is a 16-bit read/write register that increments with each pulse from the count clock signal selected with the TMCLK field in Timer Control Register n (TMnCON, n=0-5). Always use 16-bit access for this register. Reading or writing 8-bit data produces unreliable operation.

After a system reset, this register contains 0x0000. Writing "1" to TMnEN, the bit with the same number in the Timer Enable Register (TMEN), starts the counter. Writing "1" to TMnDIS, the bit with the same number in the Timer Disable Register (TMDIS), stops the counter.

Counter overflow generates an interrupt request (FTMOVn, n=0 - 5) and loads the contents of Timer Register n (TMnR, n=0 - 5) into TMnC.

A write to TMnC automatically copies the same value to TMnR.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 7.4 : Timer Counters 0 to 5 (TMnC, n=0 - 5)

7.2.4 Timer Registers 0 to 5 (TMnR, n=0 - 5)

Timer Register n (TMnR, n=0 - 5) is a 16-bit read/write register that holds the value that timer channel n loads into Timer Counter n (TMnC, n=0 - 5) when the latter overflows.

Always use 16-bit access for this register. Reading or writing 8-bit data produces unreliable operation.

After a system reset, this register contains 0x0000.

A write to Timer Counter n TMnC automatically copies the same value to TMnR.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure	7.5	: Timer	Registers	0 to 5	(TMnR.	n=0 - 5)
					(

7.2.5 Timer General-Purpose Registers 0 to 5 (TMnGR, n=0 - 5)

Timer General-Purpose Register n (TMnGR, n=0-5) is a 16-bit read/write register that, in the compare out (CMO) and pulse width modulation (PWM) modes, holds a value for comparison to Timer Counter n (TMnC, n=0-5) and, in capture (CAP) mode, holds the TMnC contents at the moment of event input from Timer Input n pin (TMIN[n], n=0-5).

Always use 16-bit access for this register. Reading or writing 8-bit data produces unreliable operation. After a system reset, this register contains 0x0000.

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0

Figure 7.6 :	: Timer General-Pur	pose Registers 0	to 5 (TMnGR. I	n=0 - 5)
- igaio i.o.		pooo i logioloi o o			,

7.2.6 Timer I/O Level Registers 0 to 5 (TMnIOLV, n=0 - 5)

Timer I/O Level Register n (TMnIOLV, n=0 - 5) is an 8-bit read/write register that, in the compare out (CMO) and pulse width modulation (PWM) modes, specifies the output level for Timer Output n pin (TMOUT[n], n=0 - 5) and, in capture (CAP) mode, specifies the trigger condition for capture event input from Timer Input n pin (TMIN[n], n=0 - 5).

After a system reset, this register contains 0x00.

7

0

6

0

5 0

4	3	2	1	0		
0	0	0	IOL	V		
				Compai	re out (CMO)mode	
			F	IOLV	Timer output	
				00	Set to "0" if TMnC matches TMnGR.	
				01	Set to "1" if TMnC matches TMnGR.	
				10	Reverse if TMnC matches TMnGR.	
				11	Operation not guaranteed.	
				Pulse w	idth modulation(PWM) mode	
			-	- IOLV	Timer output	
				00	Set to "0" if TMnC is equal to or less	
					than TMnGR, and to "1" otherwise.	
				01	Set to "1" if TMnC is equal to or less	
					than TMnGR, and to "0" otherwise.	
				1X	Operation not guaranteed.	
				Capture		
			F	IOLV	Event trigger	
				00	Ignore events.	
				01	Rising edges of TMIN[n]	
				10	Falling edges of TMIN[n]	
				11	Both edges of TMIN[n]	

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.7 : Timer I/O Level Registers 0 to 5 (TMnIOLV, n=0-5)

Bit Descriptions

IOLV

- Auto-reload timer (ART) mode does not use this field.
- Compare out (CMO) mode uses this field to specify the output level for Timer Output n pin (TMOUT[n], n=0-5) through Timer Output Register n (TMnOUT, n=0-5)when Timer Counter n (TMnC, n=0-5) matches Timer General-Purpose Register n (TMnGR, n=0-5). The choices are: "0," "1," and alternating output.
- Pulse width modulation (PWM) mode uses this field to specify the TMOUT[n] output level through TMnOUT based on a size comparison between Timer Counter n (TMnC, n=0 - 5) and Timer General-Purpose Register n (TMnGR, n=0 - 5).
- Capture (CAP) mode uses this field to specify the TMIN[n] (n=0 5) trigger condition that is, the events at which the timer channel copies the Timer Counter n (TMnC, n=0 5) contents to Timer General-Purpose Register n (TMnGR, n=0 5). The choice are: rising edges, falling edges, and both edges.

7.2.7 Timer Output Registers 0 to 5 (TMnOUT, n=0 - 5)

Timer Output Register n (TMnOUT, n=0 - 5) is an 8-bit read/write register that holds the output level for Timer Output n pin (TMOUT[n], n=0 - 5).

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.8 : Timer Output Registers 0 to 5 (TMnOUT, n=0 - 5)

Bit Descriptions

TMOUT

This bit holds the output level for Timer Output n pin (TMOUT[n], n=0 - 5). It can be modified by the program or the timer channel in compare out (CMO) or pulse width modulation (PWM) mode. If there is a conflict, the program takes precedence.

Setting it to "1" sets TMOUT[n] to "H" level; resetting it to "0," to "L" level.

- In compare out (CMO) mode, the value written by the program remains in effect until the next compare match, but is then updated in the manner specified in the IOLV field in Timer I/O Level Register n (TMnIOLV, n=0 5).
- In pulse width modulation (PWM) mode, the value written by the program remains in effect until the next clock pulse and is then updated in the manner specified in the IOLV field.

7.2.8 Timer Enable Register (TMEN)

The Timer Enable Register (TMEN) is an 8-bit read/write register for starting timer channels.

After a system reset, this register contains 0x00.

Bit TMnEN (n=0 - 5) controls timer channel n.

7	6	5	4	3	2	1	0
0	0	TM5EN	TM4EN	TM3EN	TM2EN	TM1EN	TM0EN

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.9 : Timer Enable Register (TMEN)

Bit Descriptions

TMnEN (n=0 - 5)

The TMnEN (n=0 - 5) bit enables timer n. Writing "1" to it sets it to "1" and starts timer channel n. Writing "0" produces no change.

7.2.9 Timer Disable Register (TMDIS)

The Timer Disable Register (TMDIS) is an 8-bit write-only register for stopping timer channels.

After a system reset, this register contains 0x00.

Bit TMnDIS (n=0 - 5) controls timer channel n.

7	6	5	4	3	2	1	0
0	0	TM5DIS	TM4DIS	TM3DIS	TM2DIS	TM1DIS	TMODIS

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 7.10 : Timer Disable Register (TMDIS)

Bit Descriptions

TMnDIS (n=0 - 5)

The TMnDIS (n=0 - 5) bit disables timer n. Writing "1" to it resets TMnEN, the corresponding bit in the Timer Enable Register (TMEN), to "0" and stops timer channel n.

Writing "0" produces no change.

7.3 Flexible Timer (FTM) Operation

Each Flexible Timer (FTM) channel offers a choice of four operating modes:

- Auto-reload timer (ART)
- Compare out (CMO)
- Pulse width modulation (PWM)
- Capture (CAP)

The MOD field in Timer Control Register n (TMnCON, n=0-5) specifies the operating mode for timer channel n.

7.3.1 Selecting Count Clock and Starting/Stopping Timers

(1) Selecting Count Clock

The TMCLK field in Timer Control Register n (TMnCON, n=0-5) specifies the count clock for timer channel n.

The choices for timer channels 0 and 1 include external clocks.

Timer channel 0 offers the following choices: SYSCLK, 2TBCCLK, 4TBCCLK, 8TBCCLK, 16TBCCLK, 32TBCCLK, rising edges of TMCLK[0], and falling edges of TMCLK[0].

Timer channel 1 offers the following choices: SYSCLK, 2TBCCLK, 4TBCCLK, 8TBCCLK, 16TBCCLK, 32TBCCLK, rising edges of TMCLK[1], and falling edges of TMCLK[1].

Timer channels 2 to 5 offer the following choices: SYSCLK, 2TBCCLK, 4TBCCLK, 8TBCCLK, 16TBCCLK, 32TBCCLK, 64TBCCLK, and 128TBCCLK.

(2) Starting/Stopping Timers

Writing "1" to the TMnEN (n=0 - 5) bit in the Timer Enable Register (TMEN) starts timer channel n. Simultaneously writing "1" to multiple bits in TMEN starts the corresponding timer channels in unison.

Writing "1" to the TMnDIS (n=0 - 5) bit in the Timer Disable Register (TMDIS) resets TMnEN to "0" and stops timer channel n. Simultaneously writing "1" to multiple bits in TMDIS stops the corresponding timer channels in unison.
7.3.2 Auto-Reload Timer (ART) Mode

Setting the MOD field in Timer Control Register n (TMnCON, n=0 - 5) to 2'b00 (ART) configures timer channel n in auto-reload timer (ART) mode.

When Timer Counter n (TMnC, n=0 - 5) overflows, the timer channel automatically copies the contents of Timer Register n (TMnR, n=0 - 5) into TMnC and generates an interrupt request (FTMOVn, n=0 - 5).

Auto-reload timer (ART) mode does not change the level at Timer Output n pin (TMOUT[n], n=0-5).

Figure 7.11 illustrates auto-reload timer (ART) operation.



Figure 7.11 : Auto-Reload Timer (ART) Operation

7.3.3 Compare Out (CMO) Mode

Setting the MOD field in Timer Control Register n (TMnCON, n=0 - 5) to 2'b01 (CMO) configures timer channel n in compare out (CMO) mode.

When Timer Counter n (TMnC, n=0 - 5) matches Timer General-Purpose Register n (TMnGR, n=0 - 5), the timer channel sets the output level for Timer Output n pin (TMOUT[n], n=0 - 5) according to the IOLV field in Timer I/O Level Register n (TMnIOLV, n=0 - 5).

2'b00: A match between TMnC and TMnGR sets the output level to "0."

2'b01: A match between TMnC and TMnGR sets the output level to "1."

2'b10: A match between TMnC and TMnGR reverses the output level.

Counter overflow and matches both generate interrupt requests - FTMOVn and EVENTn (n=0 - 5), respectively.

Figure 7.12 illustrates compare out (CMO) operation.

TMnC	I			
0xFFFF —				
TMnGR value –				
Starting value _ (from TMnR)				
0x0000 —				
FTMOVn				
EVENTn				
TMOUT [n]output for IOLV=]			
2'b00 and initial setting of				
2'b01 and initial setting of				
TMOUT [n]output for IOLV=				
2'b10 and initial setting of	Figure 7.12 : Compare	e Out (CMO) Operatio	n	

7.3.4 Pulse Width Modulation (PWM) Mode

Setting the MOD field in Timer Control Register n (TMnCON, n=0 to 5) to 2'b10 (PWM) configures timer channel n in pulse width modulation (PWM) mode.

This mode takes the period from the Timer Register n (TMnR, n=0-5) and the length of the front portion of the pulse from the Timer General-Purpose Register n (TMnGR, n=0 The timer channel sets the output level for Timer Output n pin (TMOUT[n], n=0-5) according to the IOLV field in Timer I/O Level Register n (TMnIOLV, n=0-5).

2'b00: Set output level to "0" if TMnC is equal to or less than TMnGR and to "1" otherwise.

2'b01: Set output level to "1" if TMnC is equal to or less than TMnGR and to "0" otherwise.

Counter overflow generates an interrupt request (FTMOVn, n=0 - 5).

Figure 7.13 illustrates pulse width modulation (PWM) operation.



Figure 7.13 : Pulse Width Modulation (PWM) Operation

7.3.5 Capture (CAP) Mode

Setting the MOD field in Timer Control Register n (TMnCON, n=0 - 5) to 2'b11 (CAP) configures timer channel n in capture (CAP) mode.

Arrival of a capture event, the edge (or edges) specified in the IOLV field in Timer I/O Level Register n (TMnIOLV, n=0-5), in the signal from Timer Input n pin (TMIN[n], n=0-5) causes the timer channel to copy the Timer Counter n (TMnC, n=0-5) contents to Timer General-Purpose Register n (TMnGR, n=0-5).

Counter overflow and capture events both generate interrupt requests - FTMOVn and EVENTn (n=0-5), respectively.

Figure 7.14 illustrates capture (CAP) operation.



Figure 7.14 : Capture (CAP) Operation

7.3.6 Synchronizing Starts and Stops

Simultaneously writing "1" to multiple TMnEN (n=0 - 5) bits in the Timer Enable Register (TMEN) starts the corresponding timer channels in unison.

Simultaneously writing "1" to multiple TMnDIS (n=0 - 5) bits in the Timer Disable Register (TMDIS) stops the corresponding timer channels in unison.

7.4 Signal Timing

7.4.1 Timer Clock Input Sampling

Flexible Timer (FTM) channels 0 and 1 support external clock signals. Figure 7.15 shows the timing with which the timer channel samples the external clock signal from Timer Clock Input n pin (TMCLK[n], n=0,1) and uses transitions over the sampling interval to derive the count clock for incrementing Timer Counter n (TMnC,n=0,1). Sampling is always at the rising edges of the system clock (SYSCLK) signal; incrementing, two SYSCLK rising edges later. If the TMCLK field in Timer Control Register n (TMnCON, n=0,1) specifies rising edges of the external clock signal, a transition from "L" level to "H" level produces a count clock pulse. If TMCLK specifies falling edges, a transition from "H" level to "L" level produces a count clock pulse.

The TMCLK[n] (n=0,1) input signal must have "H" level and "L" level pulses that are at least two system clock (SYSCLK) cycles long.



Figure 7.15 : Timing for Sampling External Clock Signal and Incrementing TMnC

7.4.2 Capture Trigger Input Sampling

In capture (CAP) mode, a Flexible Timer (FTM) channel configures its Timer Input/Output n pin (TMIN[n]/TMOUT[n], n=0 - 5) as a capture trigger input pin TMIN[n] (n=0 -5) with high-impedance input.

Figure 7.16 shows the timing with which the timer channel samples the signal from Timer Input n pin (TMIN[n], n=0 - 5) and uses transitions over the sampling interval to derive the load signal for copying the Timer Counter n (TMnC, n=0 - 5) contents to Timer General-Purpose Register n (TMnGR, n=0 - 5). Sampling is always at the rising edges of the system clock (SYSCLK) signal; copying, two SYSCLK rising edges later.

If the IOLV field in Timer I/O Level Register n (TMnIOLV, n=0 - 5) specifies rising edges as capture triggers, a transition from "L" level to "H" level produces a load signal pulse.

If IOLV specifies falling edges, a transition from "H" level to "L" level produces a load signal pulse. (Note that IOLV can specify both edges.)

The TMIN[n] (n=0 - 5) input signal must have "H" level and "L" level pulses that are at least two system clock (SYSCLK) cycles long.



Figure 7.16 : Timing for Sampling Capture Trigger Signal and Loading TMnGR from TMnC

7.4.3 Timer Output Timing

In compare out (CMO) or pulse width modulation (PWM) mode, a Flexible Timer (FTM) channel configures its Timer Input/Output n pin (TMIN[n]/TMOUT[n], n=0 - 5) as a timer output pin TMOUT[n] (n=0 - 5).

Figure 7.17 shows the timing with which the TMOUT [n] (n=0 - 5) level changes in compare out (CMO) mode: at the falling edge of the count clock pulse following a match between Timer Counter n (TMnC, n=0 - 5) and Timer General-Purpose Register n (TMnGR, n=0 - 5).

Figure 7.18 shows the timing with which the TMOUT[n] level changes in pulse width modulation (PWM) mode: at the falling edge of the count clock pulse following satisfaction of the specified relationship between TMnC and TMnGR.

Count clock	
TMnC	TMnGR - 1 TMnGR TMnGR + 1 TMnGR + 2
TMOUT[n]	χ
	Figure 7.17 : Timer Output Timing for Compare Out (CMO) Mode
Count clock	
TMnC	TMnGR - 1 X TMnGR X TMnGR + 1 X TMnGR + 2
TMOUT[n]	Χ

Figure 7.18 : Timer Output Timing for Pulse Width Modulation (PWM) Mode

8 Asynchronous Serial Interface

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8.1 Overview

The Asynchronous Serial Interface (ASI) is a serial port that frames (synchronizes) each character of information with start and stop elements. Parameters control transfer speed (using a dedicated baud rate generator), character length, number of stop bits, and use of parity.

- · Built-in baud rate generator
- Character length: 7 or 8 bits
- Stop bits: 1 or 2
- Parity: none, odd, or even
- Error detection for receiving: parity, framing, and overrun errors
- Full duplex operation

8.1.1 Block Diagram

Figure 8.1 gives a block diagram for the Asynchronous Serial Interface (ASI), which includes the following components:

- Baud rate generator (ASBGEN), which controls transfer speed
- ASI Control Register (ASICON), which controls transmission and reception
- ASI Buffer Register (ASBUF), interface to two buffers which hold transmitted and received data
- ASI Status Register (ASIST), which indicates transfer status
- Shift registers for transmission and reception



RVINT: Receive ready interrupt request BGINT: Baud rate interrupt request

Figure 8.1 Block Diagram for Asynchronous Serial Interface (ASI)

Figure 8.2 gives the structure of the baud rate generator (ASBGEN), which includes the following components:

- Baud Rate Timer Counter (ASBTMC)
- Baud Rate Timer Register (ASBTMR)
- Baud Rate Control Register (ASBCON)



Figure 8.2 : Block Diagram for Baud Rate Generator (ASBGEN)

8.1.2 Pins

Table 8.1 lists the pins connected to the Asynchronous Serial Interface (ASI).

Pin Name	Symbol	Direction	Description
Transmit data	ASI_TXD	Input	This output is the transmit data for the Asynchronous
		-	Serial Interface (ASI). It represents a secondary function
			for I/O port PIO5[7].
Receive data	ASI_RXD	Output	This input is the receive data for the Asynchronous Serial
			Interface (ASI). It represents a secondary function for I/O
			port PIO5[6].

Table 8.1 : Asynchronous Serial Interface (ASI) Pins

8.1.3 Control Registers

Table 8.2 lists the control registers for the Asynchronous Serial Interface (ASI).

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0300	ASI Buffer Register	ASBUF	R/W	8	Indeterminate
0x060_0301	ASI Status Register	ASIST	R/W	8	0x00
0x060_0302	ASI Control Register	ASICON	R/W	8	0x00
0x060_0303	Baud Rate Control Register	ASBCON	R/W	8	0x00
0x060_0304	Baud Rate Timer Counter	ASBTMC	R/W	8	0x00
0x060_0305	Baud Rate Timer Register	ASBTMR	R/W	8	0x00
0x060_0306	ASI Test Control Register	ASTSCON	R/W	8	0x00

Table 8.2 : Asynchronous Serial Interface (ASI) Control Registers

8.2 Control Registers

8.2.1 ASI Control Register (ASICON)

The ASI Control Register (ASICON) is an 8-bit read/write register that controls transmission and reception.

After a system reset, this register contains 0x00, which specifies the default parameters of 8-bit character, 2 stop bits, and no parity.

Always wait for current transmit and receive operations to terminate before modifying the contents of this register. Modification in the middle of such operations interferes with not only the current operation, but subsequent operations as well.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 8.3 : ASI Control Register (ASICON)

Bit Descriptions

ASRVEN

This bit enables/disables receive operation. Setting it to "1" enables receive operation; writing "0" disables it.

ASTSTB

This bit controls the number (1 or 2) of stop bits for transmit operation. Setting it to "1" sets the number of stop bits to 1; writing "0," to 2.

ASEVN

This bit specifies the parity logic (odd or even) for the parity bit, if present, for transmit and receive operation. Setting it to "1" specifies even parity; writing "0," odd parity.

ASPEN

This bit enables/disables the parity bit for transmit and receive operation. Setting it to "1" causes the interface to include the parity bit when transmitting and to check the parity when receiving; writing "0" suppresses the parity bit.

ASLN

This bit controls the character length for transmit and receive operation. Setting it to "1" sets the number of data bits to 7; writing "0," to 8.

8.2.2 ASI Buffer Register (ASBUF)

The ASI Buffer Register (ASBUF) is an 8-bit read/write register that provides a common interface to two buffers which hold transmitted and received data. Reading the register accesses the receive buffer; writing to it accesses the transmit buffer.

When a receive operation terminates, the interface transfers the contents of the receive shift register to the ASBUF receive buffer and generates a receive ready interrupt request (RVINT). The buffer contents remain valid until the completion of the next receive operation.

For a transmit operation, the interface transfers the contents written to the ASBUF transmit buffer to the transmit shift register and generates a transmit ready interrupt request (TRINT).

After a system reset, this register contains an indeterminate value.



Figure 8.4 : ASI Buffer Register (ASBUF)

8.2.3 ASI Shift Registers

The ASI shift registers are 8-bit registers that shift one bit at a time as the interface transfers the data.

These registers are not accessible from programs.

8.2.4 ASI Status Register (ASIST)

The ASI Status Register (ASIST) is an 8-bit read/write register containing transmit/ receive ready flags and error flags for errors detected during receive operations.

The interface updates the lowest three bits upon completion of each receive operation, setting the flags to "1" whenever it detects the corresponding errors in the input.

Note, however, that it does not clear a flag if a subsequent character is free of that error. It is up to the program to clear these flags.

The same applies to the transmit/receive ready flags.

To clear a flag, write "1" to it. Writing "0" produces no change.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 8.5 : ASI Status Register (ASIST)

Bit Descriptions

ATRIRQ

This flag indicates the transmit ready state. The interface sets this flag to "1" when it is ready to accept more transmit data - that is, when it transfers the contents of the transmit buffer (ASBUF) to the transmit shift register.

Note that interrupt processing does not automatically clear this flag, so the program must - by writing "1" to the bit.

ARVIRQ

This flag indicates the receive ready state. The interface sets this flag to "1" when receive data is ready - that is, when it updates the receive buffer register.

Note that interrupt processing does not automatically clear this flag, so the program must - by writing "1" to the bit.

Note also that, upon completion of each receive operation, the interface always updates the receive buffer register and sets this flag to "1" regardless of any errors in the input.

PERR

This flag indicates a parity error. If the parity bit calculated for the received data does not match the one included with the data, the interface sets this flag to "1."

OERR

This flag indicates an overrun error. If, at the end of a receive operation, the CPU has not read the ASBUF contents from the preceding receive operation, the interface sets this flag to "1."

Note, however, that the new data replaces the old in the ASBUF register.

FERR

This flag indicates a framing error. The interface interprets a "0" received for a stop bit as indicating loss of frame synchronization, so sets this flag to "1."

8.2.5 ASI Test Control Register (ASTSCON)

The ASI Test Control Register (ASTSCON) is an 8-bit read/write register that simplifies the testing of asynchronous serial interface internals by looping the ASI channel's transmit output signal back to the receive input signal.

After a system reset, this register contains 0x00. Leave it at this setting for normal operation.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 8.6 : ASI Test Control Register (ASTSCON)

Bit Descriptions

LBTST

This bit controls the looping of the ASI channel's transmit output signal back to the receive input signal. Setting it to "1" sends the transmit output signal to both the output pin and the receive input circuit. Resetting it to "0" causes the transmit and receive functions to operate independently. The transmit output signal is not looped back to the receive input signal.

MPERR

This bit is for generating a parity error. Setting this bit to "1" during loop back testing forces a parity error in the receive signal.

MFERR

This bit is for generating a framing error. Setting this bit to "1" during loop back testing forces a framing error in the receive signal.

8.2.6 Baud Rate Timer Counter (ASBTMC)

The Baud Rate Timer Counter (ASBTMC) is an 8-bit read/write register that contains the internal count for the baud rate generator (ASBGEN). Counter overflow produces the baud rate clock signal and a baud rate generator interrupt request (BGINT). The ASBTMC then reloads from the Baud Rate Timer Register (ASBTMR) and continues incrementing. The BGCK field in the Baud Rate Control Register (ASBCON) determines the ASBTMC count clock.

After a system reset, this register contains 0x00.



Figure 8.7 : Baud Rate Timer Counter (ASBTMC)

8.2.7 Baud Rate Timer Register (ASBTMR)

The Baud Rate Timer Register (ASBTMR) is an 8-bit read/write register that holds the value that the baud rate generator (ASBGEN) loads into the Baud Rate Timer Counter (ASBTMC) when the latter overflows.

After a system reset, this register contains 0x00.



Figure 8.8 : Baud Rate Timer Register (ASBTMR)

8.2.8 Baud Rate Control Register (ASBCON)

The Baud Rate Control Register (ASBCON) is an 8-bit read/write register that selects the Baud Rate Timer Counter (ASBTMC) count clock, starts and stops counting, indicates overflow, and selects the operating mode.

After a system reset, this register contains 0x00, which specifies the default clock of 2TBCCLK and leaves the counter stopped.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 8.9 : Baud Rate Control Register (ASBCON)

Bit Descriptions

BGCK

This field specifies the Baud Rate Timer Counter (ASBTMC) count clock. The choices range from 2TBCCLK to 16TBCCLK.

BGRUN

This bit controls counting by the Baud Rate Timer Counter (ASBTMC). Setting it to "1" starts counting. Resetting it to "0" stops the counter.

QSTM

A "1" in this flag indicates Baud Rate Timer Counter (ASBTMC) overflow.

Note that interrupt processing does not automatically clear this flag, so the program must - by writing "1" to the bit. Writing "0" produces no change.

BGMOD

This bit selects the baud rate generator (ASBGEN) mode. Setting it to "1" configures ASBGEN as the baud rate generator for the Asynchronous Serial Interface (ASI). Resetting it to "0" selects auto-reload timer (ART) mode. Note that the latter prevents use of the serial port because there is no baud rate clock to drive the latter's transmitter and receiver.

8.3 Asynchronous Serial Interface (ASI) Operation

8.3.1 Baud Rate Generator (ASBGEN) Operation

The baud rate generator (ASBGEN) is an 8-bit timer that generates the baud rate clock for the Asynchronous Serial Interface (ASI). If not needed for that purpose, it also offers an 8-bit auto-reload timer mode.

This unit consists of the 8-bit Baud Rate Timer Counter (ASBTMC), the 8-bit Baud Rate Timer Register (ASBTMR) holding the reload value for ASBTMC, and the Baud Rate Control Register (ASBCON) controlling ASBGEN operation.

This unit is an auto-reload timer. When ASBTMC overflows, the unit automatically reloads it from the Baud Rate Timer Register (ASBTMR) and generates a baud rate generator interrupt request (BGINT).

The following is the procedure for setting the baud rate.

(1) Starting with the desired baud rate, B, and system clock frequency, f SYSCLK, determine the values of n and D satisfying the following equation. Note, however, that n must be between 1 and 4; D, between 0 and 255.

Table 8.3 shows the n-D combinations required to produce typical baud rates for representative frequencies.

 $B = f \text{ SYSCLK x } 1/(16 \text{ x } 2^{n} \text{ x } (256\text{-}D))$ where B = baud ratef SYSCLK = system clock frequencyn = 1 - 4D = 0 - 255

- (2) Write D to the Baud Rate Timer Counter (ASBTMC) and Baud Rate Timer Register (ASBTMR).
- (3) Write n 1 to the BGCK field in the Baud Rate Control Register (ASBCON) to select the input clock.

n = 1	2'b00	2TBCCLK
n = 2	2'b01	4TBCCLK
n = 3	2'b10	8TBCCLK
n = 4	2'b11	16TBCCLK

(4) Simultaneously write "1" to the BGRUN and BGMOD bits in the same register to start the baud rate generator.

Table 8.3 : Baud Rate and the Setting Value												
SYSCLK	4MHz			4.9152MHz				5MHz			6MHz	
Baud	n	D	Error	n	D	Error	n	D	Error	n	D	Error
rate 🔪			(%)			(%)			(%)			(%)
300	4	204	0.16	4	192	0	4	191	0.16	4	178	0.16
600	4	230	0.16	4	224	0	3	191	0.16	4	217	0.16
1200	4	243	0.16	4	240	0	2	191	0.16	3	217	0.16
2400	3	243	0.16	4	248	0	1	191	0.16	2	217	0.16
4800	2	243	0.16	4	252	0	1	223	-1.36	1	217	0.16
9600	1	243	0.16	4	254	0	1	240	1.73	1	236	-2.34
19200	-	-	-	4	255	0	1	248	1.73	1	246	-2.34
31250	1	252	0	1	251	-1.70	1	251	0	1	250	0
38400	-	-	-	3	255	0	1	252	1.73	1	251	-2.34

T SYSCLK		6.144MH	lz		7.3728MI	Ηz	8MHz				9.8304MHz		
Baud	n	D	Error	n	D	Error	n	D	Error	n	D	Error	
rate			(%)			(%)			(%)			(%)	
300	4	176	0	4	160	0	4	152	0.16	4	128	0	
600	4	216	0	4	208	0	4	204	0.16	4	192	0	
1200	4	236	0	4	232	0	4	230	0.16	4	224	0	
2400	4	246	0	4	244	0	4	243	0.16	4	240	0	
4800	4	251	0	4	250	0	3	243	0.16	4	248	0	
9600	3	251	0	4	253	0	2	243	0.16	4	252	0	
19200	2	251	0	3	253	0	1	243	0.16	4	254	0	
31250	1	250	2.40	-	-	-	1	248	0	2	251	-1.70	
38400	1	251	0	2	253	0	-	-	-	4	255	0	

f sysclk		10MHz		12MHz			12.288MH	Ηz	14MHz			
Baud	n	D	Error	n	D	Error	n	D	Error	n	D	Error
rate			(%)			(%)			(%)			(%)
300	4	126	0.16	4	100	0.16	4	96	0	4	74	0.16
600	4	191	0.16	4	178	0.16	4	176	0	4	165	0.16
1200	3	191	0.16	4	217	0.16	4	216	0	3	165	0.16
2400	2	191	0.16	3	217	0.16	4	236	0	2	165	0.16
4800	1	191	0.16	2	217	0.16	4	246	0	1	165	0.16
9600	1	223	-1.36	1	217	0.16	4	251	0	1	210	-0.93
19200	1	240	1.73	1	236	-2.34	3	251	0	1	233	-0.93
31250	1	246	0	1	244	0	1	244	2.40	1	242	0
38400	1	248	1.73	1	246	-2.34	2	251	0	-	-	-

Table 8.3 : Baud Rate and the Setting Value												
t sysclk	1	14.7456M	Hz		16MHz		1	17.2032M	Hz		18MHz	
Baud	n	D	Error	n	D	Error	n	D	Error	n	D	Error
rate 🔪			(%)			(%)			(%)			(%)
300	4	64	0	4	48	0.16	4	32	0	4	22	0.16
600	4	160	0	4	152	0.16	4	144	0	4	139	0.16
1200	4	208	0	4	204	0.16	4	200	0	3	139	0.16
2400	4	232	0	4	230	0.16	4	228	0	2	139	0.16
4800	4	244	0	4	243	0.16	4	242	0	1	139	0.16
9600	4	250	0	3	243	0.16	4	249	0	1	197	-0.69
19200	4	253	0	2	243	0.16	3	249	0	1	227	1.02
31250	1	241	-1.70	1	240	0	1	239	1.20	1	238	0
38400	3	253	0	1	243	0.16	2	249	0	1	241	-2.34

f sysclk		19.6608M	Hz		20MHz			22MHz			24MHz		
Baud	n	D	Error	n	D	Error	n	D	Error	n	D	Error	
rate			(%)			(%)			(%)			(%)	
300	4	0	0	-	-	-	-	-	-	-	-	-	
600	4	128	0	4	126	0.16	4	113	0.16	4	100	0.16	
1200	4	192	0	4	191	0.16	3	113	0.16	4	178	0.16	
2400	4	224	0	3	191	0.16	2	113	0.16	4	217	0.16	
4800	4	240	0	2	191	0.16	1	113	0.16	3	217	0.16	
9600	4	248	0	1	191	0.16	1	184	-0.54	2	217	0.16	
19200	4	252	0	1	223	-1.36	1	220	-0.54	1	217	0.16	
31250	2	246	-1.70	1	236	0	1	234	0	1	232	0	
38400	4	254	0	1	240	1.73	1	238	-0.54	1	236	-2.34	

f sysclk		24.576MH	Ηz	25MHz					
Baud	n	D	Error	n	D	Error			
rate			(%)			(%)			
300	-	-	-	-	-	-			
600	4	96	0	4	93	-0.15			
1200	4	176	0	4	175	0.47			
2400	4	216	0	3	175	0.47			
4800	4	236	0	2	175	0.47			
9600	4	246	0	1	175	0.47			
19200	4	251	0	1	215	-0.76			
31250	3	250	2.40	1	231	0			
38400	3	251	0	1	236	1.73			

8.3.2 Setting Communications Parameters

The program specifies the character length, number of stop bits, and the parity for transmission and reception with the ASI Control Register (ASICON). To enable reception, it must also set the ASRVEN bit in ASICON to "1."

Figure 8.10 gives examples of ASICON settings and the corresponding frame formats.

START DO D1 D2 D3 D4 D5 D6 D7 P STOP START

(1) Parity, 8-bit word length, 1 stop bit (ASPEN = "1," ASLEN = "0," ASTSTB = "1")

 s_{TART} <u>D0</u> <u>D1</u> <u>D2</u> <u>D3</u> <u>D4</u> <u>D5</u> <u>D6</u> <u>D7</u> <u>START</u> (2) No parity, 8-bit word length, 1 stop bit (ASPEN = "0," ASLEN = "0," ASTSTB = "1")

 $\frac{1}{2}$ (3) Parity, 8-bit word length, 2 stop bits (ASPEN = "1," ASLEN = "0," ASTSTB = "0")

(4) Parity, 7-bit word length, 1 stop bit (ASPEN = "1," ASLEN = "1," ASTSTB = "1")

Figure 8.10 : Frame Format Examples

8.3.3 Transmitting Data

Writing 8-bit data to the ASI Buffer Register (ASBUF) starts the transmission sequence. If the character length is set to 7, the interface ignores bit 7, the most significant bit.

The interface transfers the data written to ASBUF to the transmit shift register, generates a transmit ready interrupt request (TRINT), and sets the ATRIRQ bit in the ASI Status Register (ASIST) to "1." This transmit ready state indicates that ASBUF is empty and thus ready to accept the next character.

The interface then transmits the bits for the frame: the start bit, seven or eight (as specified in ASI Control Register (ASICON)) data bits (LSB first), the parity bit (if specified), and the stop bit (or bits).

8.3.4 Receiving Data

To enable reception, the program must set the ASRVEN bit in the ASI Control Register (ASICON) to "1."

Then, when the interface detects a start bit, it begins receiving one frame of data in the frame format specified in ASICON. When it detects the stop bit(s), it transfers the contents of the receive shift register to the ASBUF receive buffer, generates a receive ready interrupt request (RVINT), and sets the ARVIRQ bit in the ASI Status Register (ASIST) to "1." If it detects any errors, it sets the corresponding bits (PERR, OERR, and FERR) in ASIST to "1." Transferring the receive data to the ASBUF receive buffer empties the receive shift register, clearing the interface for the next receive operation.

9 Clock Synchronous Serial Interface

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9.1 Overview

The Clock Synchronous Serial Interfaces 0,1 (CSIn, n=0,1) are two serial ports that transmit 8-bit data synchronized with internal or external clock signals.

9.1.1 Block Diagram

Figure 9.1 gives a block diagram for Clock Synchronous Serial Interfaces 0,1 (CSIn, n=0,1). The two have identical structures. Each includes the following components:

- CSI Control Register (CSInCON, n=0,1), which controls transmission and reception
- CSI Shift Register (CSnSFT, n=0,1), which shifts the transmitted and received data
- CSI Status Register (CSInST, n=0,1), which indicates transfer status







9.1.2 Pins

Table 9.1 lists the pins connected to Clock Synchronous Serial Interfaces 0,1 (CSIn, n=0,1).

Pin Name	Symbol	Direction	Description	
Channel 0	CSI0_TXD	Output	This output is the transmit data for Clock Synchronous	
transmit data			Serial Interface 0 (CSI0).	
			It represents a secondary function for I/O ports PIO5[2].	
Channel 0	CSI0_RXD	Input	This input is the receive data for Clock Synchronous	
receive data			Serial Interface 0 (CSI0).	
			It represents a secondary function for I/O port PIO5[1].	
Channel 0	CSI0_SCLK	Input or	This pin is for the Clock Synchronous Serial Interface 0	
synchronization clock		output	(CSI0) synchronization clock signal:	
			It provides clock output if the CSI channel is in master	
			mode and accepts clock input if the CSI channel is in	
			slave mode.	
			It represents a secondary function for I/O port PIO5[0].	
Channel 1	CSI1_TXD	Output	This output is the transmit data for Clock Synchronous	
transmit data			Serial Interface 1 (CSI1).	
			It represents a secondary function for I/O port PIO5[5].	
Channel 1	CSI1_RXD	Input	This input is the receive data for Clock Synchronous	
receive data			Serial Interface 1 (CSI1).	
			It represents a secondary function for I/O port PIO5[4].	
Channel 1	CSI1_SCLK	Input or	This pin is for the Clock Synchronous Serial Interface 1	
synchronization clock		output	(CSI1) synchronization clock signal:	
			It provides clock output if the CSI channel is in master	
			mode and accepts clock input if the CSI channel is in	
			slave mode.	
			It represents a secondary function for I/O port PIO5[3].	

Table 9.1 : Clock Synchronous Serial Interface (CSIn, n=0,1) Pins

9.1.3 Control Registers

Table 9.2 lists the control registers for Clock Synchronous Serial Interfaces 0,1 (CSIn, n=0,1).

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0400	CSI Shift Register 0	CSI0SFT	R/W	8	Indeterminate
0x060_0401	CSI Status Register 0	CSI0ST	R/W	8	0x00
0x060_0402	CSI Control Register 0	CSI0CON	R/W	8	0x00
0x060_0404	CSI Shift Register 1	CSI1SFT	R/W	8	Indeterminate
0x060_0405	CSI Status Register 1	CSI1ST	R/W	8	0x00
0x060_0406	CSI Control Register 1	CSI1CON	R/W	8	0x00
0x060_0407	CSI Test Control Register	CSTSCON	R/W	8	0x00

Table 9.2 : Clock Synchronous Serial Interface (CSIn, n=0,1) Control Registers

9.2 Control Registers

9.2.1 CSI Control Registers 0,1 (CSInCON, n=0,1)

CSI Control Register n (CSInCON, n=0,1) is an 8-bit read/write register that controls transmission and reception by Clock Synchronous Serial Interface n (CSIn, n=0,1).

After a system reset, this register contains 0x00.

Always wait for current transmit and receive operations to terminate before modifying the contents of this register. Modification in the middle of such operations interferes with not only the current operation, but subsequent operations as well.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 9.2 : CSI Control Register n (CSInCON, n=0,1)

Bit Descriptions

CSMSV

This bit configures Clock Synchronous Serial Interface n (CSIn, n=0,1) as master or slave.

Setting this bit to "1" configures the serial port as the master, feeding the clock signal specified with the CSSFTC field to the CSIn_SCLK (n=0,1) pin and using it to synchronize data transfers.

Resetting this bit to "0" configures the serial port as a slave using the clock signal from the $CSIn_SCLK$ (n=0,1) pin to synchronize data transfers.

CSSFTC

This field specifies the synchronization clock for master mode. It is ignored by slave mode.

The choices are half the frequencies of the time base clocks 8TBCCLK, 32TBCCLK, and 128TBCCLK from the Time Base Generator (TBG) and the overflow signal from Flexible Timer (FTM) channel n (n=0,1).

9.2.2 CSI Shift Registers 0,1 (CSInSFT, n=0,1)

CSI Shift Register n (CSInSFT, n=0,1) is an 8-bit read/write register that holds and shifts transmitted and received data for Clock Synchronous Serial Interface n (CSIn, n=0,1).

After a system reset, this register contains an indeterminate value.

In master mode, the program writes data to this register to enable a transfer. The serial port then uses the synchronization clock signal to transmit the register contents one bit at a time starting from the least significant bit (LSB) to the CSIn_TXD (n=0,1) pin and replace that bit with the input from the CSIn_RXD (n=0,1) pin.

When the 8-bit transfer is complete, the serial port stops the synchronization clock output and generates a transfer complete interrupt request n (CSINTn, n=0,1). The register contents remain valid until the start of the next transfer operation.

In slave mode, the program writes data to this register to enable a transfer. The serial port then uses the synchronization clock input from the CSIn_SCLK (n=0,1) pin to transmit the register contents one bit at a time starting from the least significant bit (LSB) to the CSIn_TXD (n=0,1) pin and replace that bit with the input from the CSIn_RXD (n=0,1) pin.

When the 8-bit transfer is complete, the serial port generates a transfer complete interrupt request n (CSINTn, n=0,1). The register contents remain valid until the program writes to this register.



Figure 9.3 : CSI Shift Register n (CSInSFT, n=0,1)

9.2.3 CSI Status Registers 0,1 (CSInST, n=0,1)

CSI Status Register n (CSInST, n=0,1) is an 8-bit read/write register giving the status of Clock Synchronous Serial Interface n (CSIn, n=0,1).

Only the BUSY bit is writeable.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 9.4 : CSI Status Register n (CSInST, n=0,1)

Bit Descriptions

SFTCT

This 3-bit, read-only field gives the contents of the shift counter. When there is no transfer underway, it contains 000b. It increments for each bit transferred, returning to 000b at the end of the transfer.

BUSY

A "1" in this flag indicates that a transfer is underway. The serial port automatically sets this bit to "1" when a transfer starts and resets it to "0" when the transfer ends.

Writing "0" to this bit while a transfer is underway aborts the transfer and initializes Clock Synchronous Serial Interface n (CSIn, n=0,1) by clearing the SFTCT field in CSI Status Register n (CSInST, n=0,1) to 000b.

9.2.4 CSI Test Control Register (CSTSCON)

The CSI Test Control Register (CSTSCON) is an 8-bit read/write register that simplifies the testing of serial port internals by looping each CSI channel's transmit output signal back to its receive input signal.

After a system reset, this register contains 0x00. Leave it at this setting for normal operation.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 9.5 : CSI Test Control Register (CSTSCON)

Bit Descriptions

LBTST

This bit controls the looping of the transmit output signals back to the receive input signals.

Setting it to "1" sends each CSI channel's transmit output signal to both the output pin (CSIn_TXD, n=0,1) and the receive input circuit. Resetting it to "0" causes the transmit and receive functions to operate independently. The transmit output signals are not looped back to the receive input signals.

9.3 Clock Synchronous Serial Interface (CSI) Operation

CSI Shift Register n (CSInSFT, n=0,1) is an 8-bit shift register that simultaneously shifts bits in from the CSIn_RXD (n=0,1) pin and shifts bits out from the CSIn_TXD (n=0,1) pin using the synchronization clock signal at the CSIn_SCLK (n=0,1) pin. These transfers are LSB first. When the transfer is complete, the serial port generates a transfer complete interrupt request n (CSINTn, n=0,1).

Figure 9.6 gives the timing for the entire transfer.



Figure 9.6 : Clock Synchronous Serial Interface Operation Timing

The serial port can be master or slave. In master mode, it uses a synchronization clock signal generated internally to shift the incoming and outgoing data and feeds that clock signal to the CSIn_SCLK (n=0,1) pin. In slave mode, it takes the synchronization clock from an external source via the CSIn_SCLK (n=0,1) pin.

The serial port writes an outgoing bit to the CSIn_TXD (n=0,1) pin at the falling edge of the CSIn_SCLK (n=0,1) signal and reads an incoming one at the rising edge. In other words, this LSI assumes that external devices transmit at the rising edge and receive at the falling edge of the synchronization clock signal.

Enabling a transfer requires writing data to the CSI Shift Register (CSInSFT, n=0,1). If the program is only receiving, it still must write dummy data. This write sets the BUSY bit in CSI Status Register n (CSInST, n=0,1) to "1." When the 8-bit transfer is complete, the serial port automatically resets this flag to "0" and generates a transfer complete interrupt request n (CSINTn, n=0,1).

In slave mode, the serial port ignores any clock pulses beyond the eighth.

Writing "0" to the BUSY bit while a transfer is underway aborts the transfer and initializes Clock Synchronous Serial Interface n (CSIn, n=0,1) by clearing the SFTCT field in CSI Status Register n (CSInST, n=0,1) to 000b. This function helps cope with loss of synchronization clock signal and other synchronization problems. Loss of synchronization clock signal leaves a nonzero value in the SFTCT field and a "1" in the BUSY bit.

The program can therefore monitor the BUSY bit with a timer or some other means and abort by forcing it to "0" if it remains at "1" beyond a certain interval.

Always wait for the current transfer operation to terminate before modifying the contents of the CSI Shift Register (CSInSFT, n=0,1). Modification in the middle of an operation destroys both incoming and outgoing data.

Table 9.3 gives the pin output levels after a system reset and between transfers - that is, between the completion of one 8-bit transfer operation and the request for another.

Pin	After a system reset	Between transfers			
CSIn_SCLK	"H" level	"H" level			
CSIn_TXD	"L" level	Most significant bit (MSB) of last data transmitted			

Table 9.3 : Output Pin States

9.4 I/O Signal Timing

9.4.1 Master Mode I/O Signal Timing

Figure 9.7 gives the I/O signal timing for master mode. The serial port feeds the synchronization clock signal to the CSIn_SCLK (n=0,1) pin, shifts the transmit data to the CSIn_TXD (n=0,1) pin, and samples the incoming data at the CSIn_RXD (n=0,1) pin. It synchronizes synchronization clock transitions between "H" level and "L" level with the rising edges of the system clock (SYSCLK) signal. It transmits outgoing bits at the falling edges of the synchronization clock signal and samples the input at the rising edge of the synchronization clock signal.

If the synchronization clock signal is the overflow signal from Flexible Timer (FTM) channel n (n=0,1), the latter must have a period at least four times that of the system clock (SYSCLK) period.


9.4.2 Slave Mode I/O Signal Timing

Figure 9.8 gives the I/O signal timing for slave mode. The serial port samples the synchronization clock signal from the CSIn_SCLK (n=0,1) pin, shifts the transmit data to the CSIn_TXD (n=0,1) pin, and samples the incoming data at the CSIn_RXD (n=0,1) pin. It samples the two inputs at the rising edges of the system clock (SYSCLK) signal. It shifts and transmits outgoing bits at transitions from "H" level to "L" level in the sampled synchronization clock signal. The sampled incoming data becomes valid at transitions from "L" level to "H" level in that signal.

In slave mode, the synchronization clock signal from the CSIn_SCLK (n=0,1) pin must have a period at least four times that of the system clock (SYSCLK) period.



Figure 9.8 : Slave Mode I/O Signal Timing

10 Analog-to-Digital Converter

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10.1 Overview

The Analog-to-Digital Converter (ADC) is an 8-bit successive approximation analog-to-digital converter with eight analog input channels and four result registers.

It offers two operating modes: scan mode, which sequentially converts the inputs from the selected set of four input channels, and select mode, which converts the input from a single input channel.

- Resolution: 8 bits
- Eight analog input channels
- · Four result registers for holding conversion results
- · Operating modes
 - Scan modes: Sequential conversion of the analog inputs from the upper or lower set of four input channels
 - Select mode: Conversion of the analog input from a single input channel

10.1.1 Block Diagram

Figure 10.1 gives a block diagram for the Analog-to-Digital Converter (ADC), which includes the following components:

- Successive approximation analog-to-digital converter, which converts an analog quantity into a digital one
- Analog input channel selector
- AD Control Registers H, L (ADHCON and ADLCON), which control analog-to-digital converter operation
- AD Status Register (ADST), which indicates the completion of a conversion operation
- AD Result Registers 0 to 3 (ADCRn, n=0 3), which hold the conversion results



ADINT: A/D conversion complete interrupt request

Figure 10.1 : Block Diagram for Analog-to-Digital Converter (ADC)

10.1.2 Pins

Table 10.1 lists the pins connected to the Analog-to-Digital Converter (ADC).

Table T0. T. Analog-to-Digital Converter (ADC) Fins				
Pin Name	Symbol	Direction	Description	
Reference voltage	VREF	Input	This input is the reference voltage for the analog-to-digital converter. Connect it to V DD.	
Analog input channels	AI[7:0]	Input	These are analog signal input pins for analog-to-digital converter channels 7 to 0.	

Table 10.1 : Analog-to-Digital Converter (ADC) Pins

10.1.3 Control Registers

Table 10.2 lists the control registers for the Analog-to-Digital Converter (ADC).

Table 10.2 ·	Analog_to_Digital	Converter (Control	Rogista	are	
Table T0.2.	Analog-to-Digital	Converter	, DU		regist	513	
Addroop	Namo		c,	mhal		Cizo.	

Address	Name	Symbol	R/W	Size	Initial value
				(bits)	
0x060_0500	AD Control Register H	ADHCON	R/W	8	0x00
0x060_0501	AD Status Register	ADST	R/W	8	0x00
0x060_0502	AD Control Register L	ADLCON	R/W	8	0x00
0x060_0504	AD Result Register 0	ADCR0	R	8	Indeterminate
0x060_0505	AD Result Register 1	ADCR1	R	8	Indeterminate
0x060_0506	AD Result Register 2	ADCR2	R	8	Indeterminate
0x060_0507	AD Result Register 3	ADCR3	R	8	Indeterminate

10.2 Control Registers

10.2.1 AD Control Register H (ADHCON)

AD Control Register H (ADHCON) is an 8-bit read/write register that specifies the operating mode and controls starting and stopping for the analog-to-digital converter.

After a system reset, this register contains 0x00.

7	6	5	4	3	2	1	0		
ADRUN	CONT	ADCH	IMOD	0		ADSTCH	1		
							- ADS	тсн	AD channel for select
									mode
							000		CH0
							001		CH1
							010		CH2
							011		CH3
							100		CH4
							101		CH5
							110		CH6
							111		CH7
			I						
							ADC	HMOD	AD operating mode
							00		CH0 to CH3 scan mode
							01		CH4 to CH7 scan mode
							10		Select (single-channel)mode
							11		Operation not guaranteed.
							0	Continu	ous operation disabled
							1	Continu	ous operation enabled
I							0	Stop co	onversion
							1	Start co	onversion

A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 10.2 : AD Control Register H (ADHCON)

Bit Descriptions

ADRUN

This bit controls starting. Setting it to "1" starts A/D conversion.

If the CONT bit is "0," the analog-to-digital converter automatically resets this bit to "0" and shuts down after four conversions for the scan modes and after one for select mode.

Resetting this bit to "0" from the program forces termination and leaves indeterminate results in the AD Result Registers 0 to 3 (ADCRn, n=0-3).

CONT

This bit enables/disables continuous operation. Setting it to "1" produces continuous cycling from channel 3 to channel 0 for CH0 to CH3 scan mode, from channel 7 to channel 4 for CH4 to CH7 scan mode, or with the same channel for select mode. Resetting it to "0" disables this cycling, causing the analog-to-digital converter to stop at the end of the 4-channel group for the scan modes or after the current conversion for select mode, reset the ADRUN bit to "0," and shut down.

ADCHMOD

This field specifies the operating mode. The choices are a scan mode covering input channels CH0 to CH3, a scan mode covering input channels CH4 to CH7, and select mode covering a single channel. If a conversion is underway, wait for the ADRUN bit to return to "0" before writing to this field. If that bit is "1," writes are ignored.

ADSTCH

This field specifies the analog input channel for select mode.

If a conversion is underway, wait for the ADRUN bit to return to "0" before writing to this field. If that bit is "1," changes are ignored.

10.2.2 AD Control Register L (ADLCON)

AD Control Register L (ADLCON) is an 8-bit read/write register that specifies the conversion time (in clock cycles) per channel for the analog-to-digital converter.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 10.3 : AD Control Register L (ADLCON)

Bit Descriptions

ADTM

This field specifies the conversion time per channel in system clock (SYSCLK) cycles. If a conversion is underway, wait for the ADRUN bit to return to "0" before writing to this field. If that bit is "1," changes are ignored.

Note The two highest settings impose upper bounds on the system clock frequency, f SYSCLK. Exceeding these limits produces invalid results. (See Table.)

Frequency Range	Supported ADTM Settings
12.5MHz < f SYSCLK<=25MHz	00, 01
6.25MHz < f SYSCLK<=12.5MHz	00, 01, 10
4MHz < f SYSCLK<=6.25MHz	00, 01, 10, 11

The next Table gives the additional clock cycles required for the first conversion after writing "1" to the ADRUN bit in AD Control Register H (ADHCON). If the ADTM setting is 2'b01, for example, a scan of four input channels takes 1118 clock cycles.

(267 + 50) + (267 * 3) = 1118

ADTM Setting	Additional Cycles for First Conversion
00	67
01	50
10	25
11	12

10.2.3 AD Status Register (ADST)

The AD Status Register (ADST) is an 8-bit read/write register that indicates the completion of a conversion operation.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 10.4 : AD Status Register (ADST)

Bit Descriptions

ADERQ

This flag indicates the completion of a conversion operation. A "1" indicates completion of the specified number of conversions and updates to the result registers.

To clear this flag, write "1" to it. Writing "0" produces no change.

If the CONT bit in AD Control Register H (ADHCON) is "0," the analog-to-digital converter sets this bit to "1" after four conversions for the scan modes and after one for select mode.

If the CONT bit is "1," the analog-to-digital converter sets this bit to "1" after the last conversion in each set (channel 3 or 7) for the scan modes and after each conversion for select mode.

10.2.4 AD Result Registers 0 to 3 (ADCRn, n=0 - 3)

The AD Result Registers 0 to 3 (ADCRn, n=0-3) are 8-bit read-only registers that hold the conversion results.

After a system reset, these registers contain indeterminate values.

Analog Input Channel	AD Result Register
CH0,CH4	ADCR0
CH1,CH5	ADCR1
CH2,CH6	ADCR2
СН3,СН7	ADCR3



Figure 10.5 : AD Result Registers 0 to 3 (ADCRn, n=0 - 3)

10.3 Analog-to-Digital Converter (ADC) Operation

The analog-to-digital converter's three operating modes fall into two types: the scan modes and select mode. AD Control Register H (ADHCON) specifies the mode.

The scan modes sequentially convert analog inputs from four channels (CH0 to CH3 or CH4 to CH7), storing the individual results in the AD Result Registers 0 to 3 (ADCRn, n=0 - 3) assigned to the channels. Setting the ADRUN bit in ADHCON to "1" starts conversion.

After four conversions, the analog-to-digital converter generates an A/D conversion complete interrupt request (ADINT) and sets the ADREQ bit in the AD Status Register (ADST) to "1." If the CONT bit in ADHCON is "0," the analog-to-digital converter then resets the ADRUN bit to "0" and shuts down. If the CONT bit is "1," specifying continuous operation, the analog-to-digital converter leaves the ADRUN bit at "1," and operation continues.

Select mode converts analog input from a single channel, storing the individual results in the AD Result Register (ADCRn, n=0-3) assigned to that channel. Setting the ADRUN bit in ADHCON to "1" starts conversion. After conversion, the analog-to-digital converter generates an A/D conversion complete interrupt request (ADINT) and sets the ADREQ bit in the AD Status Register (ADST) to "1." If the CONT bit in ADHCON is "0," the analog-to-digital converter then resets the ADRUN bit to "0" and shuts down. If the CONT bit is "1," specifying continuous operation, the analog-to-digital converter leaves the ADRUN bit at "1," and operation continues.

Switching from a scan mode to select mode in the middle of a scan cycle is not possible. Terminate the scan mode conversions first.

Figure 10.6 shows the execution timing for A/D conversion. Figure 10.7 gives examples of stored results.



Figure 10.6 : A/D Conversion Timing

		_	
ADCR0	A/D conversion result from channel 0	ADCR0	A/D conversion result from channel 4
ADCR1	A/D conversion result from channel 1	ADCR1	A/D conversion result from channel 5
ADCR2	A/D conversion result from channel 2	ADCR2	A/D conversion result from channel 6
ADCR3	A/D conversion result from channel 3	ADCR3	A/D conversion result from channel 7
	(1) CH0 to CH3 scan mode		(2) CH4 to CH7 scan mode
ADCR0	A/D conversion result from channel 0	ADCR0	A/D conversion result from channel 4
ADCR1	A/D conversion result from channel 1	ADCR1	A/D conversion result from channel 1
ADCR2	A/D conversion result from channel 6	ADCR2	A/D conversion result from channel 6
ADCR3	A/D conversion result from channel 3	ADCR3	A/D conversion result from channel 7
	(3) CHO to CH3 scan mode follo	wed by	(4) CH4 to CH7 scan mode fol

(3) CH0 to CH3 scan mode followed by select mode with channel 6

(4) CH4 to CH7 scan mode followed by select mode with channel 1

Figure 10.7 : Examples of Stored A/D Conversion Results

11 External Memory Controller

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11.1 Overview

The External Memory Controller (XMC) generates control signals for accessing external memory (ROM, SRAM, DRAM, etc.), and other devices with addresses in the external memory space. It also controls the core bus, and peripheral bus during data transfers.

- Support for direct connection of ROM, SRAM, and I/O devices
 - Strobe signal outputs for a variety of memory and I/O devices
- Support for direct connection of DRAM
 - Multiplexed row and column addresses
 - Random access and high-speed paged modes
 - Programmable wait cycle insertion
 - Support for CAS-before-RAS (CBR) refresh and self refresh
- · Memory space divided into four banks
 - Two banks for ROM, SRAM, and I/O devices
 - Two banks for DRAM
 - Address space of 16 megabytes for each bank
 - Separate data bus width (8 or 16 bits), wait cycle, and "off time" settings for each bank
- · 32-bit access to internal ROM and RAM within a single clock cycle
- · 16-bit access to on-chip peripherals within two clock cycles
- Single-stage store buffer permitting internal access during a write cycle to external memory or device
- · Arbitration of external bus requests from external devices

11.1.1 Block Diagram

Figure 11.1 gives a block diagram for the External Memory Controller (XMC), which includes the following components:

- Bus Width Control Register (BWCON), which controls the external data bus width for each bank
- Wait Input Control Register (WICON), which controls the use of nXWAIT input to insert wait cycles for each bank
- Off Time Control Register (OTCON), which controls the "off time" for each bank
- Programmable Wait Control Register (PWCON) and Bus Access Control Register (BACON), which control wait cycles and other access parameters for the SRAM banks (0 and 1)
- DRAM Bank Control Registers 2,3 (DRnCON, n=2,3), DRAM Bank Access Timing Control Registers 2,3 (ATnCON, n=2,3), DRAM Bank Programmable Wait Control Registers 2,3 (DWnCON, n=2,3), which control address multiplexing, wait cycles, and other parameters for the DRAM banks (2 and 3)
- Refresh Timer Counter (RFTCN), Refresh Cycle Control Register (RCCON), Refresh Timing Control Register (RTCON), and Refresh Control Register (RFCON), which control DRAM refresh for the DRAM banks (2 and 3)

There are two internal buses: the core bus, which connects the CPU, internal ROM, internal RAM, and control registers for the CPU control unit, and the peripheral bus, which connects all control registers outside the CPU control unit.



Figure 11.1 : Block Diagram for External Memory Controller (XMC)

11.1.2 Pins

Table 11.1 lists the pins connected to the External Memory Controller (XMC).

Pin Name	Symbol	Direction	Description
External address bus	XA23-XA1, nLB/XA0	Output	These outputs are the external address bus. The least significant bit, nLB/XA0, doubles as bit 0 of the external address bus and as the Low Byte Select signal for the SRAM banks (0 and 1). The top eight bits, XA23 to XA16, represent secondary functions for I/O port PIO0[7:0].
External data bus	XD15-XD0	Bi-directional	These are the external data bus. The upper eight bits, XD15 to XD8, represent secondary functions for I/O port PIO1[7:0].
Bank 0 chip select	nCS0	Output	This output is the chip select signal for bank 0.
Bank 1 chip select	nCS1	Output	This output is the chip select signal for bank 1. It represents a secondary function for I/O port PIO2[6].
SRAM bank (0 or 1) read	nRD	Output	This output is the read signal for the SRAM banks (0 and 1).
SRAM bank (0 or 1) write	nWRE/nWRL	Output	This output is the Write Enable Low signal (nWRL) or Write Enable signal (nWRE) for the SRAM banks (0 and 1).
SRAM bank (0 or 1) write	nHB/nWRH	Output	This output is the Write Enable High signal (nWRH) or High Byte Select signal (nHB) for the SRAM banks (0 and 1). It represents a secondary function for I/O port PIO2[5].
Bank 2 RAS	nRAS0	Output	This output is the Row Address Strobe signal for bank 2. It represents a secondary function for I/O port PIO2[2].
Bank 3 RAS	nRAS1	Output	This output is the Row Address Strobe signal for bank 3. It represents a secondary function for I/O port PIO2[4].
DRAM bank (2 or 3) CAS	nCASL/nCAS	Output	This output is the Column Address Strobe signal (nCAS) or Column Address Strobe Low signal (nCASL) for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[1].
DRAM bank (2 or 3) write/CAS	nCASH/nWH	Output	This output is the Write Enable High signal (nWH) or Column Address Strobe High signal (nCASH) for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[3].
DRAM bank (2 or 3) write	nWE/nWL	Output	This output is the Write Enable Low signal (nWL) or Write Enable signal (nWE) for the DRAM banks (2 and 3). It represents a secondary function for I/O port PIO2[0].
Wait input	nXWAIT	Input	This input pin controls insertion of wait cycles. It represents a secondary function for I/O port PIO2[7].

Table 11.1 : External Memory Controller (XMC) Pins

Table 11.1 : External Memory Controller (XMC) Pins				
Pin Name	Symbol	Direction	Description	
Bus request	nBREQ	Input	This input is a bus request signal from an external device. It represents a secondary function for I/O port PIO7[6].	
Bus acknowledgment	nBACK	Output	This output is an acknowledgment signal to a bus request signal from an external device. It represents a secondary function for I/O port PIO7[7].	
Data bus width selection	DBSEL	Input	During a system reset of this LSI, this input specifies the width of the external data bus for bank 0. Connect this pin to V DD for a data bus width of 16 bits and to ground for 8 bits.	
Internal ROM selection	nEA	Input	During a system reset of this LSI, this input controls the use of the internal ROM. Connect this pin to V DD to enable the ROM and to ground to disable it.	

11.1.3 Control Registers

Table 11.2 lists the control registers for the External Memory Controller (XMC).

Address	Name	Symbol	R/W	Size (bits)	Initial value
0x060_0700	Bus Width Control Register	BWCON	R/W	8	0x0E/0F
0x060_0701	Wait Input Control Register	WICON	R/W	8	0x00
0x060_0702	Off Time Control Register	OTCON	R/W	8	0xFF
0x060_0703	Programmable Wait Control Register	PWCON	R/W	8	0x77
0x060_0704	Bus Access Control Register	BACON	R/W	8	0x00
0x060_0705	DRAM Bank 2 Control Register	DR2CON	R/W	8	0x00
0x060_0706	DRAM Bank 2 Access Timing Control Register	AT2CON	R/W	8	0x05
0x060_0707	DRAM Bank 2 Programmable Wait Control Register	DW2CON	R/W	8	0x03
0x060_0708	DRAM Bank 3 Control Register	DR3CON	R/W	8	0x00
0x060_0709	DRAM Bank 3 Access Timing Control Register	AT3CON	R/W	8	0x05
0x060_070A	DRAM Bank 3 Programmable Wait Control Register	DW3CON	R/W	8	0x03
0x060_070B	Refresh Timer Counter	RFTCN	R/W	8	0xFF
0x060_070C	Refresh Cycle Control Register	RCCON	R/W	8	0xFF
0x060_070D	Refresh Timing Control Register	RTCON	R/W	8	0x37
0x060_070E	Refresh Control Register	RFCON	R/W	8	0x00
0x060_070F	Cycle Trace Control Register	CTCON	R/W	8	0x00

Table 11.2 : External Memory Controller (XMC) Control Registers

11.1.4 Address Spaces

The core architecture supports an address space of 4 gigabytes, but this LSI uses only the first 64 megabytes, divided into four equal banks. Table 11.3 outlines the address assignments for these banks.

Bank	Addresses	Memory Assignments	Size	Chip Select Output	Data Bus Width
0	0x00000000 to 0x001FFFFF	Internal ROM or external ROM, RAM,	2MB	-	32b
		or I/O devices		or	or
				nCS0	8/16b
	0x00200000 to 0x003FFFFF	Internal RAM	2MB	-	32b
	0x00400000 to 0x005FFFFF	Internal I/O devices on core bus	2MB	-	32b
	0x00600000 to 0x006FFFFF	Internal I/O devices on peripheral bus	1MB	-	16b
	0x00700000 to 0x007FFFFF	Reserved area	1MB	-	16b
	0x00800000 to 0x00FFFFFF	External ROM, RAM, or I/O devices	8MB	nCS0	8/16b
1	0x01000000 to 0x01FFFFFF	External ROM, RAM, or I/O devices	16MB	nCS1	8/16b
2	0x02000000 to 0x02FFFFFF	External DRAM	16MB	nRAS0	8/16b
3	0x03000000 to 0x03FFFFFF	External DRAM	16MB	nRAS1	8/16b

Table 11.3 : Address Assignments

The top two bits of the address (A25 and A24) divide the supported address space into four banks of 16 megabytes each. These banks use fixed address ranges and connect directly to memory, peripherals, and other devices. Accessing a bank automatically generates the strobe signals appropriate for the address range.

Bank 0 is further subdivided into the following address ranges:

- Addresses 0x00000000 to 0x001FFFFF are switchable between internal ROM and external devices (ROM, RAM, or I/O devices). The nEA input level during a system reset determines which. Grounding the pin disables the internal ROM and assigns the address range to external devices. Connecting the pin to V DD causes addresses in this range to access the internal ROM. Note, however, that only the first 128 kilobytes (0x00000000 to 0x0001FFFF) are physically present.
- Addresses 0x00200000 to 0x003FFFFF access internal RAM. Note, however, that only the first 4 kilobytes (0x00200000 to 0x00200FFF) are physically present.
- Addresses 0x00400000 to 0x005FFFFF access internal I/O devices on the core bus that is, control registers for the CPU control unit.
- Addresses 0x00600000 to 0x006FFFFF access internal I/O devices on the peripheral bus that is, control registers outside the CPU control unit.
- Addresses 0x00700000 to 0x007FFFFF are a reserved area and must not be used.
- Addresses 0x00800000 to 0x008FFFFF are for external devices (ROM, RAM, or I/O devices).

Note: Do not access addresses between 0x00000000 and 0x006FFFFF for which there is no internal ROM, internal RAM, or control register physically present or addresses 0x00700000 to 0x007FFFFF. Doing so produces unreliable operation.

Bank 1 is for external devices (ROM, RAM, or I/O devices).

Banks 2 and 3 are for DRAM. Accessing an address in these ranges generates the appropriate nRAS, nCAS, and multiplexed address signals.

External memory areas offer a separate data bus width (8 or 16) specification for each bank.

Figure 11.2 is a memory map showing these address assignments.

Address





11.2 Control Registers

11.2.1 Bus Width Control Register (BWCON)

The Bus Width Control Register (BWCON) is an 8-bit read/write register that controls the external data bus width for each bank.

After a system reset, this register contains a value that depends on the DBSEL input level during the reset. "H" level (VDD) input sets the register to 0x0F; "L" level (GND) input, to 0x0E.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.3 : Bus Width Control Register (BWCON)

Bit Descriptions

BWBn (n=0-3)

The BWBn bit specifies the external data bus width for bank n. Setting it to "1" selects 16 bits; resetting it to "0," 8 bits. (Note that this setting does not affect access to bank 0 internal devices via the 32-bit core bus and 16-bit peripheral bus.)

After a system reset, the BWB0 bit reflects the DBSEL input level during the reset. "H" level (VDD) input (BWB0 = "1") sets the width to 16 bits; "L" level (GND) input (BWB0 = "0"), to 8 bits.

11.2.2 Wait Input Control Register (WICON)

The Wait Input Control Register (WICON) is an 8-bit read/write register that controls sampling of nXWAIT input to insert wait cycles during access to external devices for each bank.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.4 : Wait Input Control Register (WICON)

Bit Descriptions

WIBn (n=0-3)

The WIBn bit enables/disables sampling of nXWAIT input for bank n. Setting it to "1" enables sampling, causing the controller to insert wait cycles when the nXWAIT signal is asserted. A "0" disables sampling.

11.2.3 Off Time Control Register (OTCON)

The Off Time Control Register (OTCON) is an 8-bit read/write register that specifies the number of system clock (SYSCLK) cycles ("off time") inserted when changing banks or changing from read access to write access within the same bank. Such pauses prevent bus collisions for output data from external memory and peripheral devices.

After a system reset, this register contains 0xFF.



Figure 11.5 : Off Time Control Register (OTCON)

Bit Descriptions

OTCNn (n=0-3)

The OTCNn (n=0-3) field specifies the number of system clock (SYSCLK) cycles ("off time") inserted when changing from bank n to another bank or changing from read access to write access within bank n. Such pauses prevent bus collisions for output data from external memory and peripheral devices. The range is from 0 (no pausing) to 3.

When switching from bank 0 to bank 2, for example, the External Memory Controller (XMC) uses the number from OTCN0.

11.2.4 Programmable Wait Control Register (PWCON)

The Programmable Wait Control Register (PWCON) is an 8-bit read/write register whose two halves specify the number of programmable wait cycles automatically inserted for accesses to the SRAM banks (0 and 1).

After a system reset, this register contains 0x77.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.6 : Programmable Wait Control Register (PWCON)

Bit Descriptions

PWNn (n=0,1)

This field specifies the number of wait cycles automatically inserted for accesses to bank n. The range is from 0 (no pausing) to 7.

11.2.5 Bus Access Control Register (BACON)

The Bus Access Control Register (BACON) is an 8-bit read/write register that specifies the access methods for 16-bit bus access to the SRAM banks (0 and 1). One access method uses two Byte Select signals; the other two Write Enable signals.

After a system reset, this register contains 0x00. Do not set the BASn bits to different values. Doing so produces unreliable operation.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.7 : Bus Access Control Register (BACON)

Bit Descriptions

BASn (n=0,1)

The Byte Access Specification n (BASn, n=0,1) bit specifies the access method for 16-bit SRAM in bank n, switching the nWRE/nWRL, nHB/nWRH, and nLB/XA0 pins between two different configurations. Setting it to "1" configures the pins as one Write Enable signal and two Byte Select signals (nWRE, nHB and nLB); resetting it to "0," as two Write Enable signals and one Byte Select signal (nWRH and nWRL).

Set both bits to the same value so that the two banks use the same signals.

11.2.6 DRAM Bank 2 and 3 Control Registers (DRnCON, n=2,3)

The DRAM Bank n Control Register (DRnCON, n=2,3) is an 8-bit read/write register that controls access to DRAM bank n, specifying the row address shift for the multiplexed address, the access method (two Column Address Strobe signals or two Write Enable signals) for 16-bit access, and the access mode (random access or high-speed paged).

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.8 : DRAM Bank 2 and 3 Control Registers (DRnCON, n=2,3)

Bit Descriptions

AMUX

The Address Multiplexing (AMUX) field specifies the number of bits that the multiplexed address for bank n shifts the row address. Select the number, between 8 and 11, that matches the DRAM and the data bus width.

DBAS

The Data Byte Access Specification (DBAS) bit specifies the access method for 16-bit access to bank n, switching the nWL/nWE, nWH/nCASH, and nCAS/nCASL pins between two different configurations. Setting it to "1" configures the pins as two Write Enable signals and one Column Address Strobe signal (nWL, nWH, and nCAS); resetting it to "0," as one Write Enable signal and two Column Address Strobe signals (nWE, nCASH, and nCASL).

BE

The Burst Enable (BE) bit specifies the access mode (random access or high-speed paged) for bank n. Setting it to "1" specifies high-speed paged mode; resetting it to "0," random access mode.

11.2.7 DRAM Bank 2 and 3 Access Timing Control Registers (ATnCON, n=2,3)

The DRAM Bank n Access Timing Control Register (ATnCON, n=2,3) is an 8-bit read/ write register that specifies the RAS precharge time (tRP) and the RAS-to-CAS delay (tRCD), the delay between asserting the nRAS signal and asserting the nCAS signal, during access to DRAM bank n.

After a system reset, this register contains 0x05.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.9 : DRAM Bank 2 and 3 Access Timing Control Registers (ATnCON, n=2,3)

Bit Descriptions

RP

The RAS Precharge (RP) bit specifies t RP, the RAS precharge time, for bank n. Setting it to "1" specifies two clock cycles; resetting it to "0," one.

RCD

The RAS-to-CAS Delay (RCD) bit specifies t RCD, the RAS-to-CAS delay, for bank n. Setting it to "1" specifies two clock cycles; resetting it to "0," one.

11.2.8 DRAM Bank 2 and 3 Programmable Wait Control Registers (DWnCON, n=2,3)

The DRAM Bank n Programmable Wait Control Register (DWnCON, n=2,3) is an 8-bit read/write register that specifies the number of wait cycles automatically added to the CAS assertion time during access to DRAM bank n.

After a system reset, this register contains 0x03.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.10 : DRAM Bank 2 and 3 Programmable Wait Control Registers (DWnCON, n=2,3)

Bit Descriptions

CAWA

The CAS Access Wait Added (CAWA) field specifies the number of wait cycles automatically added to the CAS assertion time during access to DRAM bank n. The range is from 0 (no wait cycles added) to 3.

11.2.9 Refresh Timer Counter (RFTCN)

The Refresh Timer Counter (RFTCN) is an 8-bit read/write decrementing counter that controls the timing for CAS-before-RAS (CBR) refresh cycle requests for the DRAM banks (2 and 3). It uses a time base clock from the Time Base Generator (TBG) as its count clock and the contents of the Refresh Cycle Control Register (RCCON) as its starting value. Setting either CBRR bit in the Refresh Control Register (RFCON) to "1" loads this register from RCCON and starts the countdown. When the count reaches 0x00, the circuitry initiates a CBR refresh cycle, waits for it to complete, reloads this register from RCCON, and starts a new countdown.

After a system reset, this register contains 0xFF.



Figure 11.11 : Refresh Timer Counter (RFTCN)

11.2.10 Refresh Cycle Control Register (RCCON)

The Refresh Cycle Control Register (RCCON) is an 8-bit read/write register holding a starting value that determines the interval between CAS-before-RAS (CBR) refresh cycles for the DRAM banks (2 and 3). Setting either CBRR bit in the Refresh Control Register (RFCON) to "1" loads the contents of this register into the Refresh Timer Counter (RFTCN) and starts the countdown. When the count reaches 0x00, the circuitry initiates a CBR refresh cycle, waits for it to complete, reloads the contents of this register into RFTCN, and starts a new countdown.

After a system reset, this register contains 0xFF.



Figure 11.12 : Refresh Cycle Control Register (RCCON)

11.2.11 Refresh Timing Control Register (RTCON)

The Refresh Timing Control Register (RTCON) is an 8-bit read/write register that specifies the RAS precharge time (tRPS) and CAS hold time (tCHS) for switching the DRAM banks (2 and 3) back from self-refresh mode to normal operation mode.

After a system reset, this register contains 0x37.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.



Bit Descriptions

CHS

The CAS Hold Self-refresh (CHS) field specifies t CHS, CAS hold time, for switching back from self-refresh mode to normal operation mode. The range is from 1 clock cycle to 4.

RPS

The RAS Precharge Self-refresh (RPS) field specifies t RPS, the RAS precharge time, for switching back from self-refresh mode to normal operation mode. The range is from 2 clock cycles to 9.

11.2.12 Refresh Control Register (RFCON)

The Refresh Control Register (RFCON) is an 8-bit read/write register that controls CAS-before-RAS (CBR) refresh and self-refresh operation for the DRAM banks (2 and 3) and specifies the count clock for the Refresh Timer Counter (RFTCN).

After a system reset, this register contains 0x00.

Do not change the CBRR field after replacing the initial 00b with a nonzero value to activate the CAS-before-RAS (CBR) refresh function. Changing from a nonzero value to any other value produces unreliable operation.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.14 : Refresh Control Register (RFCON)

Bit Descriptions

CLKS

The Clock Selection (CLKS) field specifies the count clock for the Refresh Timer Counter (RFTCN). The choices are the time base clocks 2TBCCLK to 256TBCCLK.

RSR

The Self-Refresh (RSR) bit switches to and from DRAM self-refresh operation.

Setting this bit to "1" causes completion of the current access to assert first the nCAS signal and then the nRAS signal long enough to activate DRAM self-refresh operation. Subsequent access to a DRAM bank (2 or 3) resets this bit to "0" and automatically switches back from self-refresh mode to normal operation mode. Writing "0" to this bit forces a return as well. When switching back from self-refresh mode, the controller negates the nRAS signal, first waits the number of clock cycles specified by the CAS Hold Self-refresh (CHS) field in the Refresh Timing Control Register (RTCON) before negating the nCAS signal, and then waits the number of clock cycles specified by the RAS Precharge Self-refresh (RPS) field in RTCON before asserting the nRAS signal to disable DRAM self-refresh operation and switch back to normal operation mode.

CBRR

Bits 0 and 1 control CAS-before-RAS (CBR) refresh for the DRAM banks (2 and 3), respectively.

Do not change this field more than once. Changing the initial 00b to a nonzero value and then to any other value produces unreliable operation.

11.2.13 Cycle Trace Control Register (CTCON)

The Cycle Trace Control Register (CTCON), used only during application development is an 8-bit read/write register that adjusts CPU operation to emulate the in-circuit emulator's bus trace mode. Setting the CT bit to "1" suspends CPU processing while the internal core bus provides address and data outputs to external circuits.

After a system reset, this register contains 0x00.



A "0" indicates a reserved bit. Always write "0" to it. Writing "1" produces unreliable operation.

Figure 11.15 : Cycle Trace Control Register (CTCON)

Bit Descriptions

СТ

This bit controls cycle trace operation. Setting it to "1" adjusts CPU operation to emulate the in-circuit emulator's bus trace mode. Resetting it to "0" disables cycle trace operation.

11.3 Address Space Access

This LSI supports an address space of 64 megabytes. The core actually supports an address space of 4 gigabytes, but other circuits ignore the top six bits (A31 to A26). The next two bits (XA25 and XA24) divide the supported address space into four banks of 16 megabytes each. (See Table 11.3.)

Figure 11.16 shows the address format.



Figure 11.16 : Address Format

These banks use fixed address ranges and connect directly to memory, peripherals, and other devices. Accessing a bank automatically generates the strobe signals appropriate for the address range.

Bank 0 is further subdivided into the following address ranges:

- Addresses 0x00000000 to 0x001FFFFF are switchable between internal ROM and external devices (ROM, RAM, or I/O devices). The nEA input level during a system reset determines which. Grounding the pin disables the internal ROM and assigns the address range to external devices. Connecting the pin to V DD causes addresses in this range to access the internal ROM. Note, however, that only the first 128 kilobytes (0x00000000 to 0x0001FFFF) are physically present.
- Addresses 0x00200000 to 0x003FFFFF access internal RAM. Note, however, that only the first 4 kilobytes (0x00200000 to 0x00200FFF) are physically present.
- Addresses 0x00400000 to 0x005FFFFF access internal I/O devices on the core bus that is, control registers for the CPU control unit.
- Addresses 0x00600000 to 0x006FFFFF access internal I/O devices on the peripheral bus that is, control registers outside the CPU control unit.
- Addresses 0x00700000 to 0x007FFFFF are a reserved area and must not be used.
- Addresses 0x00800000 to 0x008FFFFF are for external devices (ROM, RAM, or I/O devices).
- **Note :** Do not access addresses between 0x00000000 and 0x006FFFFF for which there is no internal ROM, internal RAM, or control register physically present or addresses 0x00700000 to 0x007FFFFF. Doing so produces unreliable operation.

Bank 1 is for external devices (ROM, RAM, or I/O devices).

Banks 2 and 3 are for DRAM. Accessing an address in these ranges generates the appropriate nRAS, nCAS, and multiplexed address signals.

External memory areas offer a separate data bus width (8 or 16) specification for each bank.

11.3.1 Data Bus Width

Bus Width Bit n (BWBn, n=0 - 3) in the Bus Width Control Register (BWCON) specifies whether the external bus for bank n is 8 or 16 bits wide. Note, however, that access to the internal ROM, internal RAM, and I/O devices on the core bus - that is, control registers for the CPU control unit - is always 32 bits wide; to internal I/O devices on the peripheral bus - that is, control registers outside the CPU control unit - 16 bits wide.

After a system reset, the BWB0 bit reflects the DBSEL input level during the reset. "H" level (V DD) input (BWB0 = "1") sets the width to 16 bits; "L" level (GND) input (BWB0 = "0"), to 8 bits. This initial setting can be changed by modifying BWCON.

Half word (16-bit) access over an 8-bit bus or word (32-bit) access over a 16-bit bus takes two successive bus cycles; word (32-bit) access over an 8-bit bus, four.

11.3.2 Accessing External Memory in SRAM Banks (0 and 1)

The external memory areas in the SRAM banks (0 and 1) are designed primarily for direct connection to SRAM devices. Accessing them automatically generates the appropriate strobe signals (nCS0, nCS1, nRD, nWRE/nWRL, nHB/nWRH, and nLB/XA0).

11.3.2.1 Basic Access

Basic access, access without wait cycles, to the SRAM banks (0 and 1) takes one clock cycle for a read and two for a write.

Figure 11.17 shows the basic access timing for external memory areas in these two banks.



Figure 11.17 : Basic External Access Timing for SRAM Banks (0 and 1)

11.3.2.2 Access with Wait Cycles

The two halves of the Programmable Wait Control Register (PWCON) specify the number of programmable wait cycles automatically inserted for accesses to external memory areas in the SRAM banks (0 and 1). The range is from 0 (no pausing) to 7.

The lowest two bits in the Wait Input Control Register (WICON) permit the use of nXWAIT input to insert additional wait cycles for each bank. Sampling of nXWAIT input is at the rising edges of the system clock (SYSCLK) signal. This input must therefore satisfy setup and hold time conditions at these edges.

Figure 11.18 shows the access timing with two programmable wait cycles inserted; Figure 11.19, that with two programmable wait cycles inserted and the nXWAIT signal asserted.



Figure 11.18 : SRAM Bank Access Timing with Two Programmable Wait Cycles



Figure 11.19 : SRAM Bank Access Timing with Two Programmable Wait Cycles and nXWAIT Input

11.3.2.3 Half Word Access

Two access methods are available for 16-bit bus access to the SRAM banks (0 and 1): with one Write Enable signal and two Byte Select signals (nWRE, nHB and nLB) or with two Write Enable signals and one Byte Select signal (nWRH and nWRL). The corresponding Byte Access Specification n (BASn, n=0,1) bit in the Bus Access Control Register (BACON) switches the nWRE/nWRL, nHB/nWRH, and nLB/XA0 pins between the two different configurations. The two banks must use the same access methods.

Figure 11.20 shows write cycles for both access methods.



11.3.3 Accessing External Memory in DRAM Banks (2 and 3)

The external memory areas in the DRAM banks (2 and 3) are designed primarily for direct connection to DRAM devices. Accessing them automatically generates an address signal multiplexing the upper (row) and lower (column) addresses and the appropriate strobe signals (nRAS and nCAS).

11.3.3.1 Address Multiplexing

The Address Multiplexing (AMUX) field in the bank's DRAM Bank 2 and 3 Control Registers (DRnCON, n=2,3) specifies the number of bits that the multiplexed address shifts the row address. The range is from 8 to 11. Table 11.4 shows the effect of each setting on the address outputs.

Chip pin	(8-bit shift)	(9-bit shift)	(10-bit shift)	(11-bit shift)
XA23				
XA22				
XA21				
XA20	Indeterminate	Indeterminate	Indeterminate	Indeterminate
XA19				
XA18				
XA17				
XA16				
XA15	XA23	Indeterminate	Indeterminate	Indeterminate
XA14	XA22	XA23	Indeterminate	Indeterminate
XA13	XA21	XA22	XA23	Indeterminate
XA12	XA20	XA21	XA22	XA23
XA11	XA19	XA20	XA21	XA22
XA10	XA18	XA19	XA20	XA21
XA9	XA17	XA18	XA19	XA20
XA8	XA16	XA17	XA18	XA19
XA7	XA15	XA16	XA17	XA18
XA6	XA14	XA15	XA16	XA17
XA5	XA13	XA14	XA15	XA16
XA4	XA12	XA13	XA14	XA15
XA3	XA11	XA12	XA13	XA14
XA2	XA10	XA11	XA12	XA13
XA1	XA9	XA10	XA11	XA12
XA0	XA8	XA9	XA10	XA11

Table 11.4 : AMUX Setting and Row Address Outputs

11.3.3.2 Basic Access

Basic access, access without wait cycles, to a DRAM bank (2 or 3) takes two clock cycles for a read or a write.

Figure 11.21 shows the basic access timing for external memory areas in these two banks.



Figure 11.21 :Basic External Access Timing for DRAM Banks (2 and 3)

11.3.3.3 Access with Wait Cycles

11.3.3.3.1RAS Precharge Time

The RAS Precharge (RP) bit in the DRAM Bank 2 and 3 Access Timing Control Registers (ATnCON, n=2,3) adjusts the t RP, the RAS precharge time, for bank n to 1 or 2 clock cycles to match the system clock (SYSCLK) frequency and the type of DRAM used.

Figure 11.22 gives the timings for both selections.



Figure 11.22 : RAS Precharge Timing

11.3.3.3.2RAS-to-CAS Delay

The RAS-to-CAS Delay (RCD) bit in the DRAM Bank 2 and 3 Access Timing Control Registers (ATnCON, n=2,3) adjusts the t RCD, the RAS-to-CAS delay between assertion of the nRAS and nCAS signals, for bank n to 1 or 2 clock cycles to match the system clock (SYSCLK) frequency and the type of DRAM used.

Figure 11.23 gives the timings for both selections.



11.3.3.3.3CAS Access Wait Cycles

The CAS Access Wait Added (CAWA) field in the DRAM Bank 2 and 3 Programmable Wait Control Registers (DWnCON, n=2,3) adjusts the number of wait cycles automatically added to the CAS assertion time during access to bank n. The range is from 0 (no wait cycles added) to 3.

Figure 11.24 shows the read and write timings for a setting of 2.



Figure 11.24 : CAS Access Wait Cycle Timing

11.3.3.3.4nXWAIT Input Wait Cycles

Bits 2 and 3 in the Wait Input Control Register (WICON) enable/disable the use of nXWAIT input to insert additional wait cycles for each bank. Setting a bit to "1" enables sampling for the corresponding bank, causing the controller to insert wait cycles when the nXWAIT signal is asserted at the rising edges of the system clock (SYSCLK) signal.

This input must therefore satisfy setup and hold time conditions at these edges.

Figure 11.25 shows the access timing with two programmable wait cycles inserted and the nXWAIT signal asserted.



Figure 11.25 : Access Timing with Two Programmable Wait Cycles and nXWAIT Input

11.3.3.4 Half Word Access

Two access methods are available for 16-bit bus access to the DRAM banks (2 and 3): with one Write Enable signal and two Column Address Strobe signals (nWE, nCASH, and nCASL) or with two Write Enable signals and one Column Address Strobe signal (nWL, nWH, and nCAS). The Data Byte Access Specification (DBAS) bit in the DRAM Bank 2 and 3 Control Registers (DRnCON, n=2,3) specifies which, switching the nWE/nWL, nCASH/nWH, and nCASL/nCAS pins between two different configurations.

Figure 11.26 shows the write access timing for both access methods.



Figure 11.26 : Half Word Write Access Timing for DRAM Banks (2 and 3)

11.3.3.5 High-Speed Paged Mode (Burst) Access

The Burst Enable (BE) bit in the DRAM Bank 2 and 3 Control Registers (DRnCON, n=2,3) switches DRAM that supports high-speed paged mode from random access mode to burst operation. Setting it to "1" enables high-speed paged mode access when the upper portion of the address (row address) matches the row address for the preceding access.

Figure 11.27 illustrates high-speed paged mode (burst) operation.



Figure 11.27 : High-Speed Paged Mode (Burst) Access Timing

11.3.3.6 Refresh Access

The External Memory Controller (XMC) offers two types of DRAM refresh functions: a CAS-before-RAS (CBR) refresh function and two self-refresh functions.

11.3.3.6.1CAS-before-RAS (CBR) Refresh Function

Setting either CBRR bit in the Refresh Control Register (RFCON) to "1" activates the CAS-before-RAS (CBR) refresh function. The lower and upper bits in this field control the function for the DRAM banks (2 and 3), respectively. Setting both bits to "1" refreshes bank 2 and then bank 3.

Two parameters determine the refresh interval: the count clock, specified by the Clock Selection (CLKS) field in RFCON, and the counter value in the Refresh Cycle Control Register (RCCON). The program must therefore set these to produce an interval matching the DRAM CBR refresh specifications.

Setting CBRR to a nonzero value (2'b01, 2'b10, or 2'b11) loads the contents of RCCON into the Refresh Timer Counter (RFTCN) and starts the countdown. When the count reaches 0x00, the circuitry initiates a CAS-before-RAS (CBR) refresh cycle, reloads RFTCON from RCCON, and starts a new countdown. Do not change the CBRR field after replacing the initial 00b with a nonzero value to activate the CAS-before-RAS (CBR) refresh function. Changing from a nonzero value to any other value produces unreliable operation.

Figure 11.28 shows Refresh Timer Counter operation and CBR refresh cycles; Figure 11.29, CBR refresh timing.



Figure 11.28 : Refresh Timer Counter Operation and CBR Refresh Cycles



Figure 11.29. CBR Refresh filming

(1) Simultaneous bank access and CBR refresh requests

A CBR refresh request arising during access to a DRAM bank (2 or 3) is postponed until that access is complete. Similarly, an access request arising during CBR refresh is postponed until that CBR refresh cycle is complete.

(2) DRAM access immediately after powering on or a system reset

When the power is first applied and after the power supply voltage has reached the specified level, some DRAM devices supporting CBR refresh require a pause followed by specified minimum number of CBR refresh cycles. If such is the case, set up the Refresh Control Register (RFCON) and the Refresh Cycle Control Register (RCCON) to provide these cycles.

11.3.3.6.2Self-Refresh Functions

These functions are for use with self-refreshing DRAM devices, which switch to self-refresh mode when the controller accesses them with CAS-before-RAS access and then asserts the nRAS and nCAS signals for longer than the specified interval. (See Figure 11.30.)

When switching back from self-refresh mode, the controller negates the nRAS signal and waits (1) the number of clock cycles specified by the CAS Hold Self-refresh (CHS) field in the Refresh Timing Control Register (RTCON) before negating the nCAS signal and (2) the number of clock cycles specified by the RAS Precharge Self-refresh (RPS) field in RTCON before asserting the nRAS signal. Set these two fields to match the DRAM type.



Figure 11.30 : Self-Refresh Timing

The Self-Refresh (RSR) bit in the Refresh Control Register (RFCON) controls this function. Setting this bit to "1" causes completion of the current access to assert first the nCAS signal and then the nRAS signal long enough to activate DRAM self-refresh operation. Subsequent access to a DRAM bank (2 or 3) resets this bit to "0" and automatically switches back from self-refresh mode to normal operation mode. Writing "0" to this bit forces a return as well. When switching back from self-refresh mode, the controller negates the nRAS signal, first waits the number of clock cycles specified by the CAS Hold Self-refresh (CHS) field in the Refresh Timing Control Register (RTCON) before negating the nCAS signal, and then waits the number of clock cycles specified by the RAS Precharge Self-refresh (RPS) field in RTCON before asserting the nRAS signal.

11.3.4 External Access Functions Common to All Banks

11.3.4.1 Off Time Control

This LSI divides addresses in its external memory areas into four banks. Because of the different data output hold times for the devices in these banks, the following access sequences can lead to collisions on the external data bus (XD15 to XD0).

- Read access to one bank immediately followed by read access to another bank
- Read access to one bank immediately followed by write access to another bank or the same bank

The Off Time Control Register (OTCON) provides a means of preventing such collisions by inserting system clock (SYSCLK) cycles ("off time") between such accesses. Specify the number, 0 to 3, in the OTCNn (n=0-3) field for the bank.



Figure 11.31 and 11.32 show two examples of access timing with "off time."

Figure 11.31 : Access Timing with Off Time (a)



Figure 11.32 : Access Timing with Off Time (b)

11.3.4.2 Store Buffer

The External Memory Controller (XMC) uses a single-stage store buffer to permit access to internal devices (internal ROM, internal RAM, and control registers for on-chip peripherals) while it still writing data to external memory or an external device. Because the buffer has only a single stage, a subsequent external write request has to wait until the current write completes, freeing that buffer.

11.3.5 Accessing Bank 0 Internal Memory Areas

The bank 0 internal memory areas consist of four 2-megabyte areas assigned to internal ROM, internal RAM, control registers on the core bus, and control registers on the peripheral bus. Access to the first two takes one clock cycle. Access to the fourth, which links control registers outside the CPU control unit, takes two clock cycles. Access to the third, which links CPU control unit control registers, one clock cycle for a read and at least two clock cycles for a write.

Figure 11.33 shows the access timing for internal ROM and RAM; Figure 11.34, that for internal I/O devices on the peripheral bus.



Figure 11.34 : Access Timing for Internal I/O Devices on Peripheral Bus

11.4 Bus Arbitration

11.4.1 Bus Access and Priority

The External Memory Controller (XMC) arbitrates access to the external bus by two types of bus masters: the CPU and external devices. External devices cannot access the core and peripheral buses inside this LSI.

The controller arbitrates bus access requests from external devices and grants them access. External devices have higher priority than the CPU.

11.4.2 Requesting and Obtaining Bus Access

An external device gains access to the external bus by asserting the nBREQ signal to request access and waiting for the controller to force the CPU to release the address bus, data bus, and control pins, and assert the nBACK signal in acknowledgment - (1) in Figure 11.35. Table 11.5 lists the pins in high-impedance states when the CPU releases the external bus.

When the CAS-before-RAS (CBR) refresh request occurs, however, the controller negates the nBACK signal to ask the external device to relinquish access. The external device must immediately negate the nBREQ signal to release the bus. The pins in high-impedance states return to their normal configurations, and the controller asserts the strobe signals (nRAS and nCAS) for the CBR refresh - (2) in Figure 11.35.



Figure 11.35 :Timing for Bus Access Request and Bus release

Table 11.5 : Pins in H	ligh-Impedance States when Bus Release		
Always	I/O port pins configured for secondary function		
XA15 - 1	XA23 - 16		
nLB/XA0	XD15 - 8		
XD7 - 0	nCS1		
nCS0	nHB/nWRH		
nRD	nRAS1		
nWRE/nWRL	nWH/nCASH		
	nRAS0		
	nCAS/nCASL		
	nWL/nWE		

Granting an external device access to the external bus has the following effects on external memory access and DRAM self-refresh settings.

- External memory access stalls until the CPU regains bus access. When the external device negates the nBREQ signal to return control to the CPU, access proceeds, and the CPU resumes execution.
- Writing "1" to the RSR bit in the Refresh Control Register (RFCON) while the external device is master does not activate the DRAM self-refresh mode because nRAS and nCAS are among the pins that remain in high-impedance states. When the external device negates the nBREQ signal to return control to the CPU, these pins return to their normal configurations, and the controller asserts the strobe signals to activate the DRAM self-refresh mode.

11.4.3 Lock Operation

The CPU instruction set includes the data swap (SWP) instruction, which exchanges data between a memory location and a general-purpose register inside the CPU. While this instruction is executing, the CPU does not release the bus, and the controller ignores any bus requests from external devices.

11.5 Standby Operation

When the LSI switches to HALT mode, the External Memory Controller (XMC) switches to HALT mode at the end of the current bus cycle. Even in HALT mode, the controller still grants external bus access to external devices requesting it.

11.6 Connecting External Memory

11.6.1 Connecting ROM

Figure 11.36 shows sample configurations for external ROMs connected to memory bank 0. Both ground the nEA pin to specify execution from the external ROM.

If the ROM has a data width of 8 bits, ground the DBSEL pin to configure this LSI's external data bus for that width and connect the ROM's address inputs A0, A1, A2,... to the external address pins with the same numbers (XA0, XA1, XA2,...).

If the ROM has a data width of 16 bits, connect the DBSEL pin to V DD to configure this LSI's external data bus for that width and connect the ROM's address inputs A0, A1, A2,... to the external address pins offset by 1 (XA1, XA2, XA3,...) and leave XA0 unused.

After the system reset, this LSI then executes code starting from address 0x00000000 in the external ROM.

Connecting the nEA pin to VDD, however, configures the LSI to execute code from the internal ROM located at addresses 0x00000000 to 0x001FFFFF. Only accesses to addresses between 0x00800000 and 0x00FFFFFF assert nCS0 and generate external bus cycles.

Altering the sample configurations in Figure 11.36 to connect the nEA pin to V DD, therefore, causes the LSI to read from the external ROM for addresses between 0x00800000 and 0x00FFFFFF.





Figure 11.36 : Connecting External ROM



Figure 11.36 : Connecting External ROM

11.6.2 Connecting SRAM

Figure 11.37 shows sample configurations with the external data bus width to memory bank 1 set to 16 bits for connecting SRAMs with data widths of 8 or 16 bits.

Connecting the nEA pin to V DD and resetting the LSI with the nRST pin configures PIO0 for its primary function as an I/O port, so the program must first reconfigure it for its secondary function as the external address bus pins XA23 to XA16. Set the BWB1 bit in the Bus Width Control Register (BWCON) to "1" to set the external data bus width to 16.

The first example uses paired SRAMs each with a data width of 8 bits, so set the BAS1 bit in the Bus Access Control Register (BACON) to access the bank with two Write Enable (nWE) signals. The second example uses an SRAM with a data width of 16 bits and separate nLB and nUB pins, so set the BAS1 bit to "1" to access the bank with two Byte Select signals (nHB and nLB).



(1) SRAM with 8-bit data width

Figure 11.37 : Connecting External SRAM



Figure 11.37 : Connecting External SRAM

11.6.3 Connecting DRAM

Figure 11.38 shows a sample configuration with the external data bus width to memory bank 2 set to 16 bits for connecting a DRAM with a data width of 16 bits.

Because this LSI uses an early write cycle, ground the DRAM's nOE pin. Set the BWB2 bit in the Bus Width Control Register (BWCON) to "1" to set the external data bus width to 16. This example uses a DRAM with a data width of 16 bits and separate nLCAS and nUCAS pins, so set the DBAS bit in the DRAM Bank Control Register 2 (DR2CON) to "0" to access the bank with two Column Address Strobe (nCAS) signals.

Because the DRAM has a data width of 16 bits and 9 pins each for the row and column addresses, set the Address Multiplexing (AMUX) field in DR2CON to 2'b01 to shift the row address 9 bits.



Figure 11.38 : Connecting External DRAM

Revision History

Revision History

Document No.	Date	Page			
		Previous Edition	Current Edition	Description	
FEUL670100-01	April, 1999	-	_	First Edition	
FEUL670100-02	January 14, 2003	-	_	Added "Preface, Notation, Revision History"	
		1-10	1-10	Added "nTRST,TDI,TMS,TCK,TDO" in Table 1.2	
		_	4-23	Added "4.7 Notes on Processing Interrupts"	

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